

## Introduction

The RNWF02 Module is a low power 2.4 GHz IEEE® 802.11b/g/n compliant, fully RF certified wireless module designed for IoT (Internet of Things) applications. These modules are interfaced via a two-wire or four-wire UART interface with Microchip's simple ASCII-based AT commands for easy integration into most of the applications. The host microcontroller can dynamically configure the RNWF02 module with a few simple ASCII commands.

The Module operates at a single supply voltage  $V_{DD}$  (3.3V typical), certain Input Output (IOs) pins support a voltage range of 1.8-3.6V by supplying the  $V_{DDIO}$  pin separately.

The RNWF02 module is available with an on-board Printed Circuit Board (PCB) antenna or U.FL connector for an external antenna and with or without Trust&Go CryptoAuthentication™ device.

## Features

- Compliant with IEEE® 802.11 b/g/n Single Spatial Stream of 20 MHz Channel Bandwidth
- Transmission Control Protocol/Internet Protocol (TCP/IP)-Based Connectivity Protocols Along with SSL and MQTT Capabilities
- Supports STA Mode and Soft AP Functionality in IEEE 802.11 Infrastructure and IBSS Networks
- Protected Management Frame (PMF) Handled in Hardware, WPA3 Support
- Integrated Power Amplifier (PA) and TX/RX Switch and Power Management
- Internal Flash Memory to Store Firmware
- Immutable Secure Boot with Hardware Root of Trust
- Supports Host Assisted Over-the-Air (OTA) Firmware Update
- On-Chip Network Stack to Offload MCU<sup>(1)</sup>
  - Network features – TCP, UDP, DHCP, ARP, HTTP, MQTT, IPv6 TLS 1.2 and DNS
  - Hardware accelerators for Wi-Fi® and TLS security to improve connection time
- Optional low-power secondary oscillator (RTCC oscillator) 32.768 KHz for real-time clock and calendar applications<sup>(1)(2)</sup>
- Hardware-Based IEEE 802.15.2 Compliant Three-Wire Packet Traffic Arbitration (PTA) Interface for Wi-Fi/Bluetooth® Coexistence<sup>(1)(2)</sup>
- UART Host Interface
- Secure Device Firmware Upgrade (DFU)
- Integrated Trust&Go CryptoAuthentication™ Device (Optional)

## Security

- Hardware Accelerated Security Modes (CryptoMaster) with Built-in DMA Support
  - Encryption engines (AES and TDES with different NIST modes of operation):
    - Modes – Electronic Code Book (ECB), Cypher Block Chaining (CBC), Counter Mode (CTR), Cypher Feedback Mode (CFB) and Output Feedback Mode (OFB)

- AES key sizes: 128b, 192b and 256b
- Authentication engines:
  - SHA-1 and SHA-2
  - AES GCM (Galois/Counter mode)
  - HMAC and AES CMAC
- On-chip oscillator for NDRNG generation
- Multi-Purpose Public Key Crypto Engine Supporting the Following Algorithms:
  - ECC/ECDH/ECDSA with standard NIST prime curves up to 521-bit, Curve25519 and Ed25519
  - RSA up to 2048-bit keys

### Operating Conditions

- Operating Voltage ( $V_{DD}$ ): 3.0-3.6V (3.3V Typical), ( $V_{DDIO}$ ): 1.8-3.6V
- Operating Temperature: -40°C to 85°C

### Module Variants

- PCB Antenna:
  - RNWF02PE
  - RNWF02PC
- U.FL Connector for External Antenna:
  - RNWF02UE
  - RNWF02UC

### Package

- 28-Pin SMD Package with Shield CAN
- Size: 21.7 mm x 14.7 mm x 2.1 mm

### Applications

- Smart Factories/Control Devices
- Security Systems, CCTV
- Smart Homes/Lighting, Smart Locks
- Computing, Wi-Fi Dongles, Protocol Bridging
- Internet of Things (IoT) Sensor Tag
- Remote Control
- Wearable Smart Devices
- Industrial Control

### Certifications

- RNWF02 Module is Certified to FCC, ISED, UKCA and CE Radio Regulations
- RoHS and REACH Compliant

### Notes:

1. Refer to the [RNWF02 Application Developer's Guide](#) for the latest supported features.
2. Either the PTA functionality or the RTCC oscillator can be used. Refer to [Pin Details of RNWF02 Module](#) for more details.

# Table of Contents

|                                                    |    |
|----------------------------------------------------|----|
| Introduction.....                                  | 1  |
| Features.....                                      | 1  |
| 1. Module Ordering Information.....                | 4  |
| 2. Device Overview.....                            | 5  |
| 2.1. Pin Details of RNWF02 Module.....             | 6  |
| 2.2. Basic Connection Requirement.....             | 9  |
| 2.3. RNWF02 Module Placement Guidelines.....       | 11 |
| 2.4. RNWF02 Module Routing Guidelines.....         | 13 |
| 2.5. RNWF02 Module RF Considerations.....          | 14 |
| 2.6. RNWF02 Module Antenna Considerations.....     | 14 |
| 2.7. RNWF02 Module Reflow Profile Information..... | 20 |
| 2.8. RNWF02 Module Assembly Considerations.....    | 21 |
| 3. Electrical Specifications.....                  | 22 |
| 3.1. RNWF02 Module Absolute Maximum Ratings.....   | 22 |
| 3.2. Thermal Specifications.....                   | 22 |
| 3.3. RNWF02 Module DC Characteristics.....         | 23 |
| 3.4. RNWF02 Module AC Characteristics.....         | 24 |
| 3.5. RNWF02 Module Radio Specifications.....       | 24 |
| 4. RNWF02 Module Packaging Information.....        | 33 |
| 4.1. RNWF02 Module Packaging Marking.....          | 33 |
| 4.2. RNWF02 Module Packaging Dimension.....        | 33 |
| 5. Appendix A: Regulatory Approval.....            | 37 |
| 5.1. United States.....                            | 37 |
| 5.2. Canada.....                                   | 39 |
| 5.3. Europe.....                                   | 41 |
| 5.4. UKCA (UK Conformity Assessed).....            | 42 |
| 5.5. Other Regulatory Information.....             | 43 |
| 6. Appendix B: Acronyms and Abbreviations.....     | 44 |
| 7. Document Revision History.....                  | 46 |
| Microchip Information.....                         | 49 |
| The Microchip Website.....                         | 49 |
| Product Change Notification Service.....           | 49 |
| Customer Support.....                              | 49 |
| Microchip Devices Code Protection Feature.....     | 49 |
| Legal Notice.....                                  | 49 |
| Trademarks.....                                    | 50 |
| Quality Management System.....                     | 51 |
| Worldwide Sales and Service.....                   | 52 |

## 1. Module Ordering Information

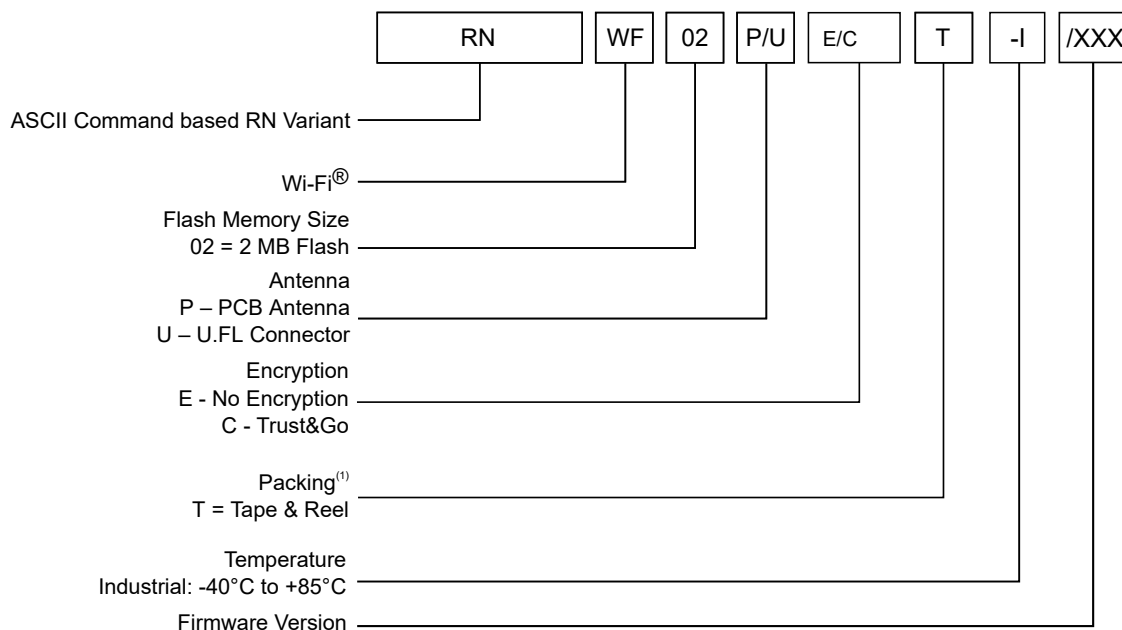
This chapter provides the ordering information of the RNWF02 module.

**Table 1-1.** RNWF02 Module Ordering Details

| Module Name | Description                                                         | Regulatory Certification | Ordering Code  |
|-------------|---------------------------------------------------------------------|--------------------------|----------------|
| RNWF02PE    | RNWF02 Module with PCB antenna                                      | FCC, ISED, CE, UKCA      | RNWF02PE-I/XXX |
| RNWF02PC    | RNWF02 Module with PCB antenna and Trust&Go                         | FCC, ISED, CE, UKCA      | RNWF02PC-I/XXX |
| RNWF02UE    | RNWF02 Module with U.FL connector for external antenna              | FCC, ISED, CE, UKCA      | RNWF02UE-I/XXX |
| RNWF02UC    | RNWF02 Module with U.FL connector for external antenna and Trust&Go | FCC, ISED, CE, UKCA      | RNWF02UC-I/XXX |

The following figure illustrates the details of the RNWF02 module ordering information.

**Figure 1-1.** RNWF02 Module Ordering Information



**Note:** By default, the WINCS02 module comes with Tray packing.

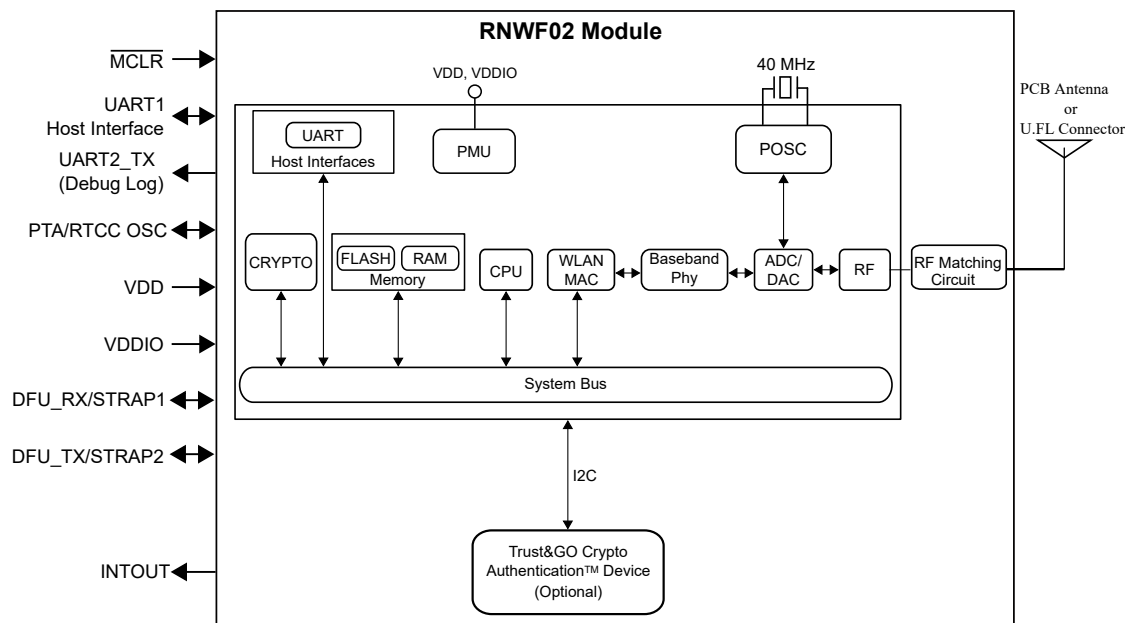
## 2. Device Overview

The RNWF02 module is a fully RF certified wireless module. The RNWF02 module is available with the following antenna variants:

- PCB antenna (RNWF02PE/RNWF02PC)
- U.FL connector (RNWF02UE/RNWF02UC) for external antenna

The following figure illustrates the RNWF02 module block diagram and various peripherals supported by the module.

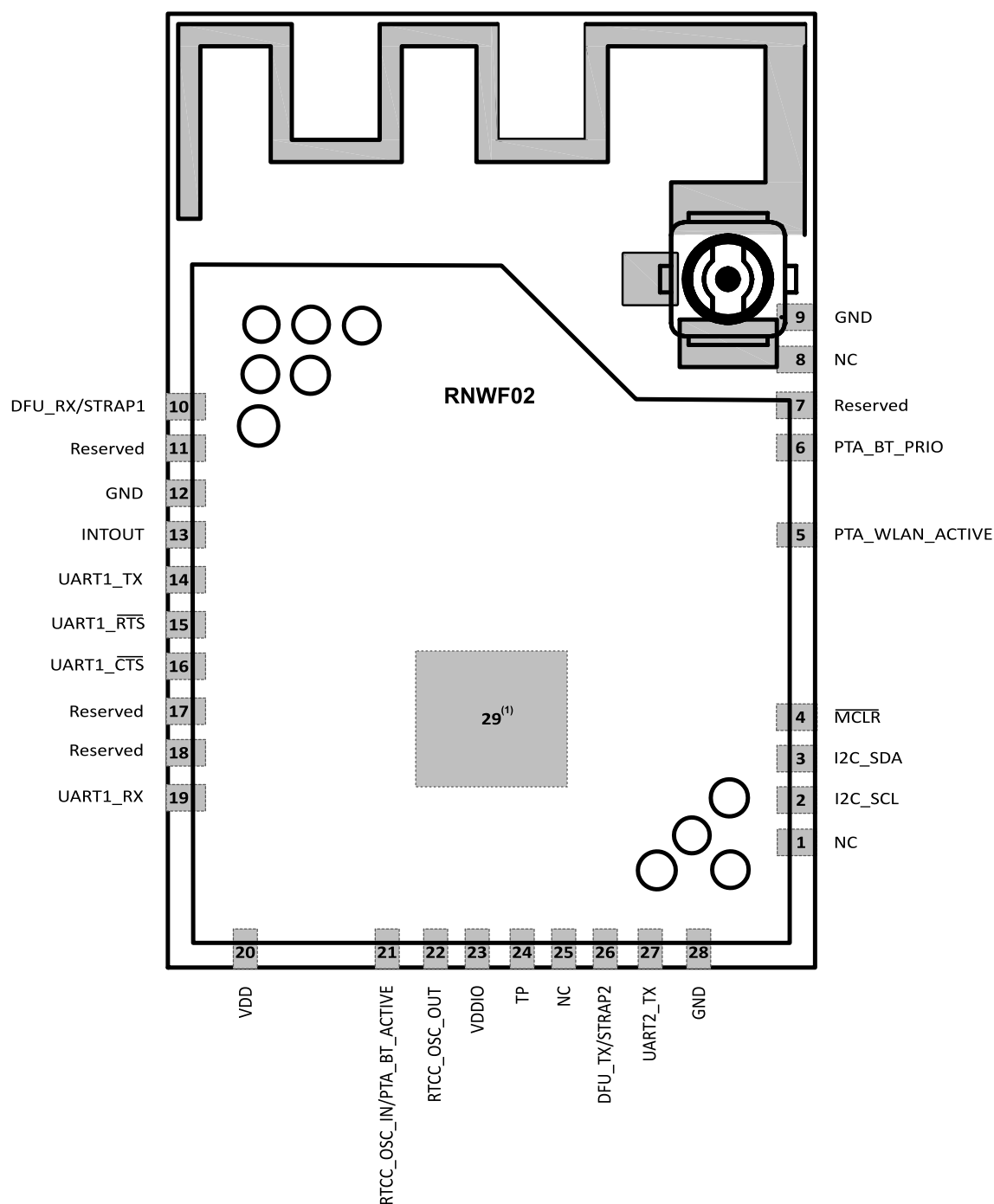
**Figure 2-1. RNWF02 Module Block Diagram**



## 2.1 Pin Details of RNWF02 Module

This section provides details on pin diagrams and pinout table of RNWF02 module.

**Figure 2-2.** RNWF02 Module Pin Diagram



**Table 2-1.** RNWF02 Module Pinout Table

| Pin Number | Pin Name | Pin Type | Pin Description |
|------------|----------|----------|-----------------|
| 1          | NC       | —        | No connection   |

.....continued

| Pin Number | Pin Name                                 | Pin Type | Pin Description                                                                                                                                                            |
|------------|------------------------------------------|----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2          | I2C_SCL <sup>(4)</sup>                   | I        | I <sup>2</sup> C clock connected to Trust&GO device. Recommended to connect external pull-up resistor of 1.2K for RNWF02PC and RNWF02UC devices                            |
| 3          | I2C_SDA <sup>(4)</sup>                   | I/O      | I <sup>2</sup> C data connected to Trust&GO device. Recommended to connect external pull-up resistor of 1.2K for RNWF02PC and RNWF02UC devices                             |
| 4          | MCLR                                     | I        | Master clear Reset, active-low                                                                                                                                             |
| 5          | PTA_WLAN_ACTIVE                          | O        | PTA interface, WLAN Active indication output to Bluetooth® Coexistence device                                                                                              |
| 6          | PTA_BT_PRIO                              | I        | PTA interface, Bluetooth Coexistence device priority indication input to RNWF02                                                                                            |
| 7          | Reserved                                 | I/O      | Reserved pin<br>Do not connect                                                                                                                                             |
| 8          | NC                                       | —        | No connection                                                                                                                                                              |
| 9          | GND                                      | P        | Ground                                                                                                                                                                     |
| 10         | DFU_RX/Strap1                            | I/O      | Device firmware update, receive signal<br>Host interface configuration, Strapping1 pin. For more details on the exact configuration, refer to <a href="#">Table 2-2</a> .  |
| 11         | Reserved <sup>(5)</sup>                  | I/O      | Reserved pin<br>Connect to an I/O pin (tri-stated) of a host device or connect to an external switch for future use.                                                       |
| 12         | GND                                      | P        | Ground                                                                                                                                                                     |
| 13         | INTOUT                                   | O        | Interrupt request (Active low) from the Wi-Fi® module                                                                                                                      |
| 14         | UART1_TX <sup>(2)</sup>                  | O        | UART1 transmit, Host interface.<br>Default: 230,400 baud<br>8N1<br>No flow control                                                                                         |
| 15         | UART1_RTSn                               | O        | UART1 Request-to-Send (active low), Host interface                                                                                                                         |
| 16         | UART1_CTSn                               | I        | UART1 Clear-to-Send (active-low), Host interface                                                                                                                           |
| 17         | Reserved                                 | I/O      | Reserved pin<br>Do not connect.                                                                                                                                            |
| 18         | Reserved                                 | I/O      | Reserved pin<br>Do not connect.                                                                                                                                            |
| 19         | UART1_RX <sup>(2)</sup>                  | I        | UART1 receive, Host interface.<br>Default: 230,400 baud<br>8N1<br>No flow control                                                                                          |
| 20         | VDD                                      | P        | VDD power supply (3.0-3.6V)                                                                                                                                                |
| 21         | RTCC_OSC_IN/PTA_BT_ACTIVE <sup>(1)</sup> | I        | 32.768 KHz RTCC Oscillator input<br>PTA interface, Bluetooth Coexistence device active indication input to RNWF02                                                          |
| 22         | RTCC_OSC_OUT                             | O        | 32.768 KHz RTCC Oscillator output                                                                                                                                          |
| 23         | VDDIO                                    | P        | I/O power supply (1.8-3.6V)                                                                                                                                                |
| 24         | TP                                       | P        | Test point: 1.5V <sup>(3)</sup>                                                                                                                                            |
| 25         | NC                                       | —        | No connection                                                                                                                                                              |
| 26         | DFU_TX/Strap2                            | I/O      | Device Firmware Update, transmit signal<br>Host interface configuration, Strapping2 pin. For more details on the exact configuration, refer to <a href="#">Table 2-2</a> . |

.....continued

| Pin Number | Pin Name                | Pin Type | Pin Description                                                                            |
|------------|-------------------------|----------|--------------------------------------------------------------------------------------------|
| 27         | UART2_TX <sup>(2)</sup> | O        | UART2 transmit signal for the debug log<br>Default: 460,800 baud<br>8N1<br>No flow control |
| 28         | GND                     | P        | Ground                                                                                     |
| 29         | GND Paddle              | P        | Thermal ground pad                                                                         |

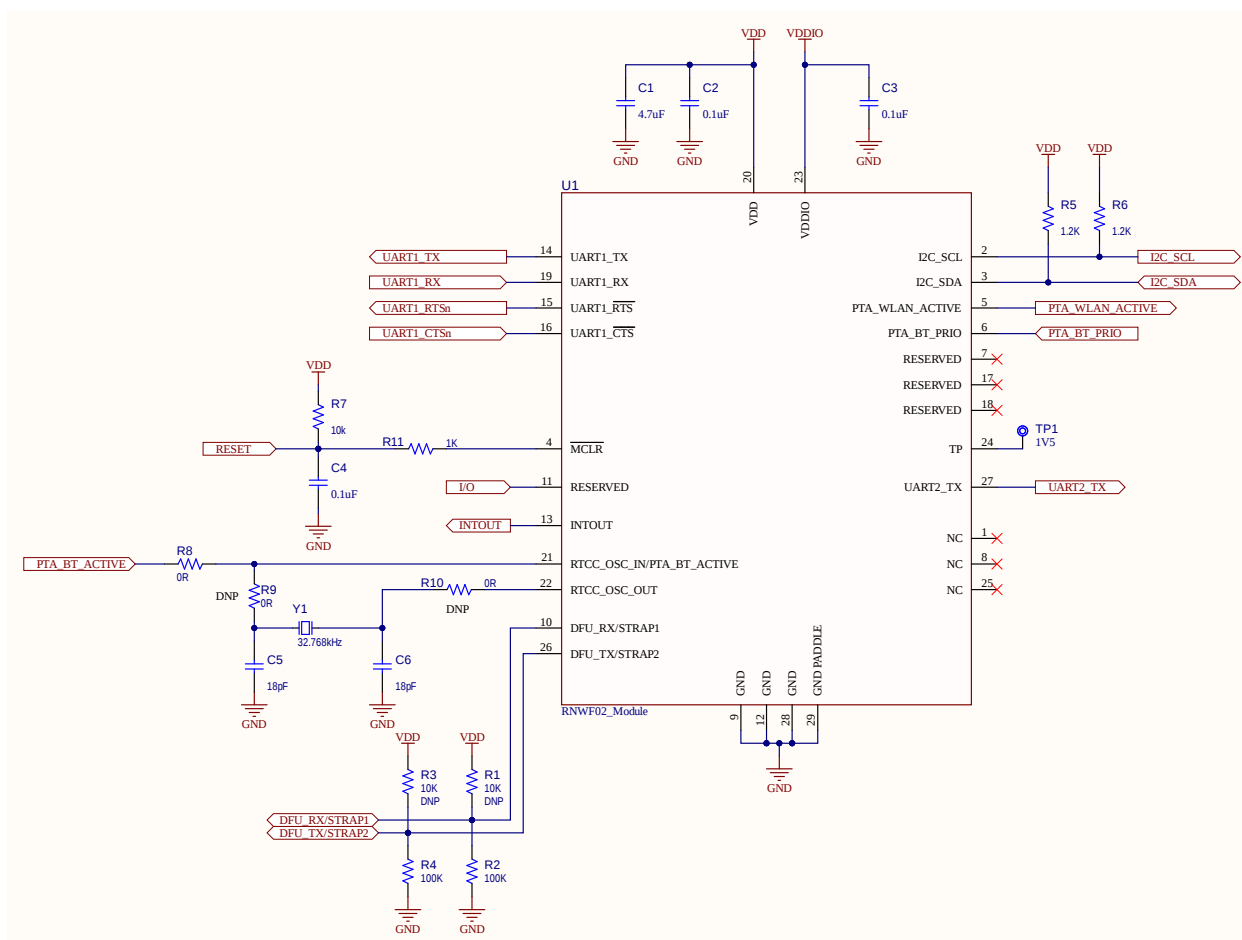
**Notes:**

1. This pin can be configured either as an oscillator input pin or as PTA BT\_ACTIVE. The RNWF02 module does not support both the functionality together.
2. These pins support lower voltage by supplying the V<sub>DDIO</sub> pin separately (1.8V - 3.6V).
3. Do not connect any signal to source the voltage.
4. I<sup>2</sup>C is not available for user configuration. It is connected to the Trust&Go secure device in the RNWF02PC and RNWF02UC module.
5. Do not leave this pin unconnected. Follow as described in the Pin Description column for future upgrade.

## 2.2 Basic Connection Requirement

The RNWF02 module requires attention to a minimal set of device pin connections before proceeding with development.

**Figure 2-3.** RNWF02 Module Basic Connection and Interface Diagram



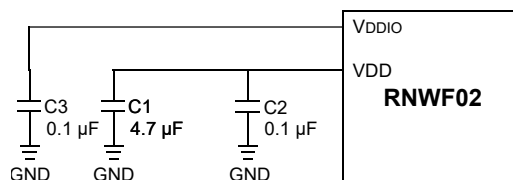
**Table 2-2.** Configuration Details

| Configuration Details                                                                                                                                                                                                                                                                                                                                                                  |                     |                          |                          |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------|--------------------------|--------------------------|
| Module Pin10/Strap1 <sup>(1)</sup>                                                                                                                                                                                                                                                                                                                                                     | Module Pin26/Strap2 | Host Interface Selection | Description              |
| X                                                                                                                                                                                                                                                                                                                                                                                      | 0 (Pull-down)       | UART1                    | RNWF02 module with UART1 |
| <b>Notes:</b> <ol style="list-style-type: none"> <li>It is recommended to provide an option to mount the pull-down resistor of 100K in the host board design for future upgrade.</li> <li>The mentioned resistance values are only guidelines. For details on the application schematics, refer to the <i>RNWF02 Add On Board User's Guide</i> (<a href="#">DS5003575</a>).</li> </ol> |                     |                          |                          |

### 2.2.1 Power Supply Pin

It is recommended to add a bulk and a decoupling capacitor at the input supply Pin 20 (VDD), Pin 23 (VDDIO) and GND of the RNWF02 module.

VDD and VDDIO can be connected to the same supply for the typical 3.3V operation. For I/Os to operate at a lower voltage, typically 1.8V, VDDIO can be connected separately along with a decoupling capacitor.

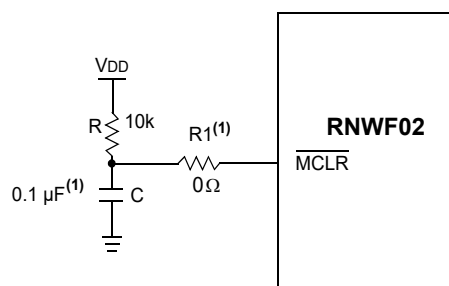
**Figure 2-4.** Recommended Module Power Supply Connections

The value of the C1 and C2 capacitors may vary based on the application requirements and source of supply voltage. The C1 and C2 capacitor must be placed close to the pin.

### 2.2.2 Master Clear ( $\overline{\text{MCLR}}$ ) Pin

The  $\overline{\text{MCLR}}$  pin works as a device Reset.

Pulling the  $\overline{\text{MCLR}}$  pin low generates a device Reset. The basic connection and interface diagram of the module illustrates a typical  $\overline{\text{MCLR}}$  circuit. See *Module Basic Connection and Interface Diagram* in the *Basic Connection Requirement* from Related Links.

**Figure 2-5.** Example of  $\overline{\text{MCLR}}$  Pin Connections

#### Note:

1. The capacitor can be sized to prevent unintentional Resets from brief glitches or to extend the device Reset period during POR.

#### Related Links

[Basic Connection Requirement](#)

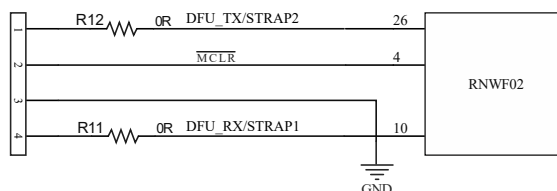
### 2.2.3 Device Firmware Update

The RNWF02 module is available for purchase with pre-programmed firmware. Microchip periodically releases the firmware to fix reported issues or to implement the latest feature support. There are two ways to perform a regular firmware update:

1. Serial DFU command-based update over UART
2. Host-assisted Over-the-Air (OTA) update

**Note:** For the serial DFU and OTA programming guidance, refer to the [RNWF02 Application Developer's Guide](#).

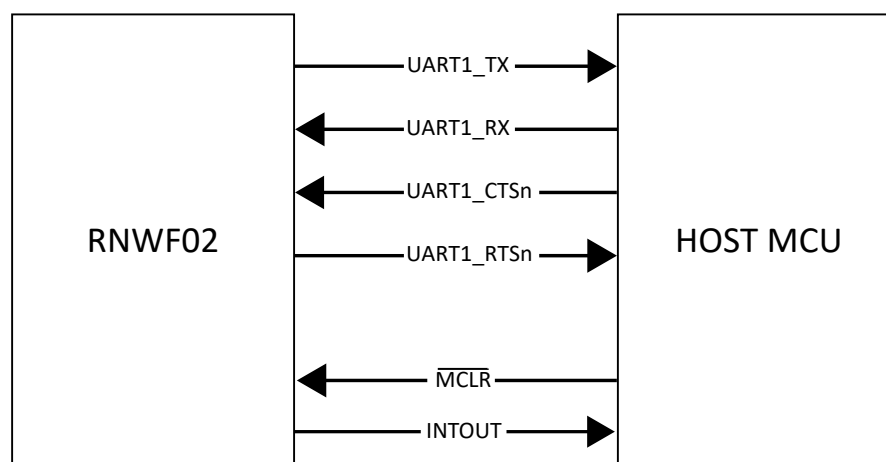
**Figure 2-6.** Basic Connection Diagram of DFU



## 2.2.4 Interface with Host Microcontroller

The RNWF02 module can be interfaced with the host microcontroller through the UART1\_TX and UART1\_RX data line and optional UART flow control signals UART1\_RTSn and UART1\_CTSn.

**Figure 2-7.** RNWF02 Module Host Interface Diagram



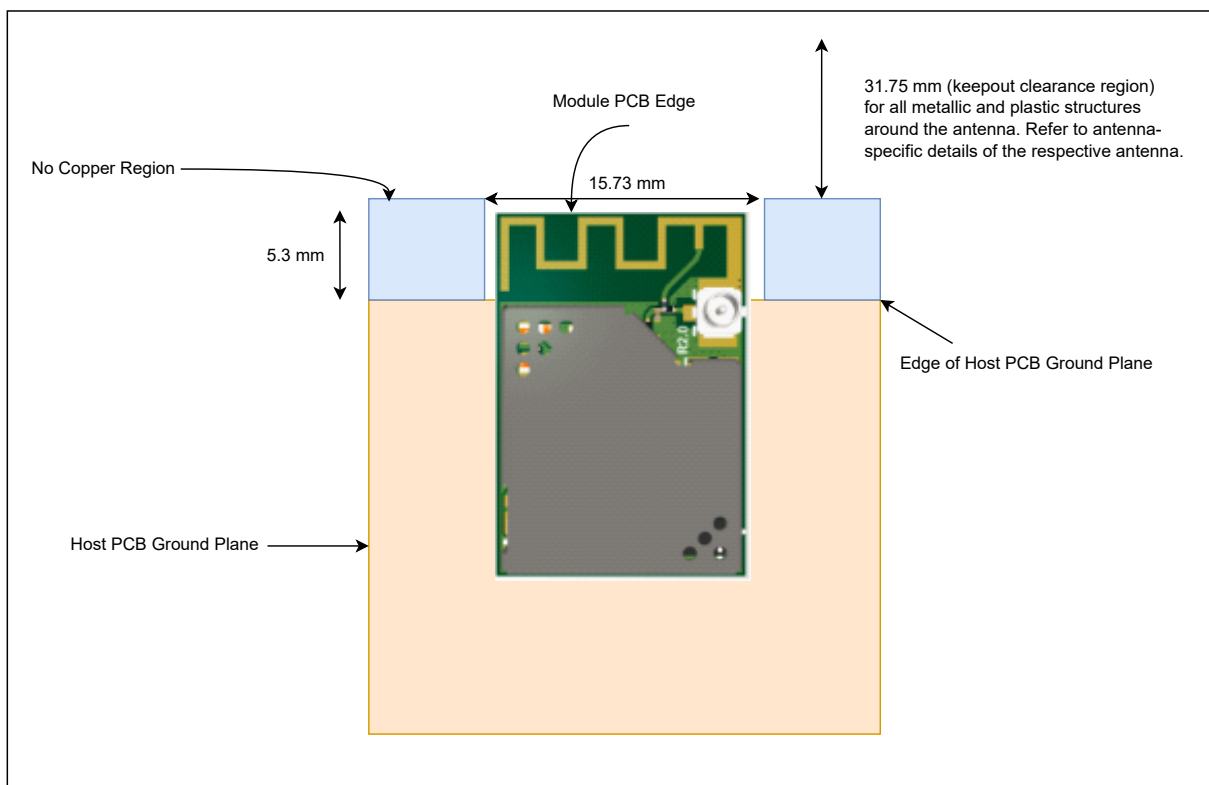
## 2.3 RNWF02 Module Placement Guidelines

- For any Wi-Fi product, the antenna placement affects the performance of the whole system. The antenna requires free space to radiate RF signals, and it must not be surrounded by the ground plane. Thus, for the best PCB antenna performance, it is recommended that the RNWF02PC/E module is placed at the edge of the host board.
- The RNWF02PC/RNWF02PE module ground outline edge must be aligned with the edge of the host board ground plane as shown in the following figure.
- A low-impedance ground plane for the RNWF02 module ensures the best radio performance (best range and lowest noise). The ground plane can be extended beyond the minimum recommendation as required for the host board EMC and noise reduction.
- For the best performance, keep metal structures and components (such as mechanical spacers, bump-on and so on) at least 31.75 mm away from the PCB trace antenna as illustrated in the following figure.
- The antenna on the RNWF02 module must not be placed in direct contact with or in close proximity to plastic casing or objects. Keep a minimum clearance of 10 mm in all directions around the PCB antenna as shown in the following figure. Keeping metallic and plastic objects close to the antenna can detune the antenna and reduce the performance of the device.
- Exposed GND pads on the bottom of the RNWF02 module must be soldered to the host board (see the *Example of Host Board on Top Layer* figure in the *RNWF02 Module Routing Guidelines* from Related Links).

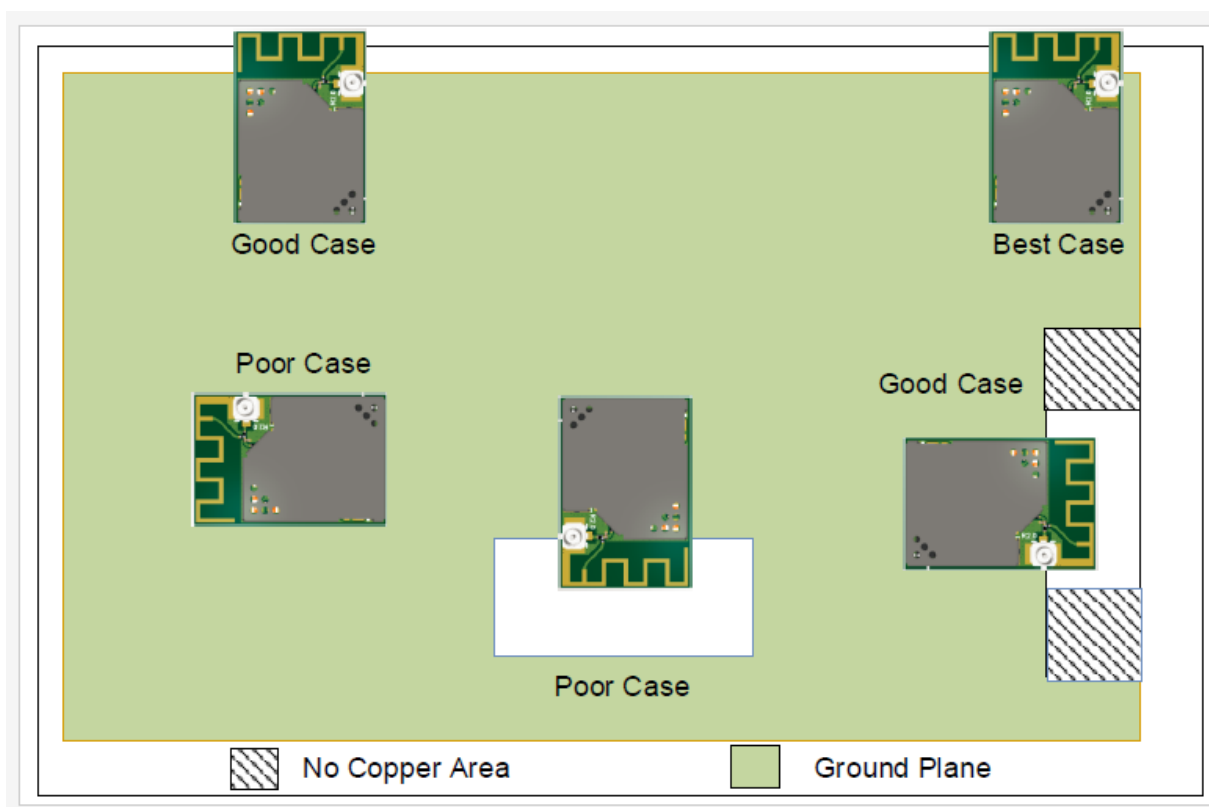
- A PCB cutout or a copper keepout is required under the RF test point (see *RNWF02 Module Packaging Information* from Related Links).
- Copper keepout areas are required on the top layer under voltage test points (see *RNWF02 Module Packaging Information* from Related Links).
- Alternatively, the entire region, except the exposed ground paddle, can be solder-masked.

The following figure illustrates the examples of RNWF02 Module placement on a host board with a ground plane. Refer to the following figure for placement-specific guidance.

**Figure 2-8. Module Placement Guidelines**

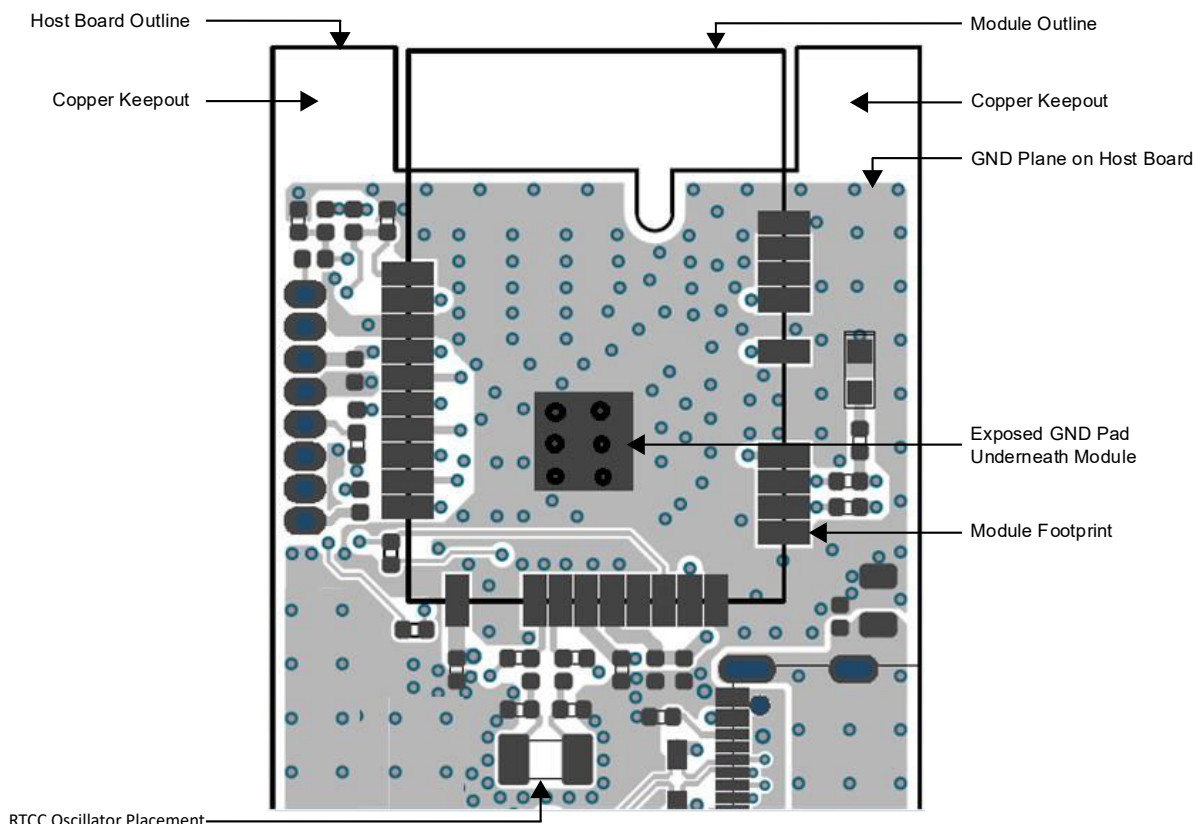


The following figure illustrates the examples of the RNWF02 module placement on a host board with a ground plane. Refer to [Figure 2-8](#) for placement-specific guidance.

**Figure 2-9. RNWF02 Module Placement****Related Links**[RNWF02 Module Routing Guidelines](#)[RNWF02 Module Packaging Information](#)**2.4 RNWF02 Module Routing Guidelines**

- Use the multi-layer host board for routing signals on the inner layer and the bottom layer.
- The top layer (underneath the module) of the host board must be ground with as many GND vias as possible as shown in the following figure.
- Avoid fan-out of the signals under the module or antenna area. Use a via to fan-out signals to the edge of the RNWF02 module.
- For a better GND connection to the RNWF02 module, solder the exposed GND pads of the RNWF02 module on the host board.
- For the module GND pad, use a GND via of a minimum 10 mil (hole diameter) for good ground to all the layers and thermal conduction path.
- Having a series resistor on the host board for all reserved pins and digital interface pins is recommended. These resistors must be placed close to the RNWF02 module. The following figure illustrates the placement of the series resistor.
- The RTCC Oscillator (32.768 kHz) on the host board must be placed close to the RNWF02 module and follow the shortest trace routing length with no vias (see the following figure).

**Figure 2-10.** Example of RNWF02 Module Placement on Host Board (Top Layer)



## 2.5 RNWF02 Module RF Considerations

The overall performance of the system is significantly affected by the product design, environment and application. The product designer must ensure system-level shielding (if required) and verify the performance of the product features and applications.

Consider the following guidelines for optimal RF performance:

- The RNWF02 module must be positioned in a noise-free RF environment and must be kept far away from high-frequency clock signals and any other sources of RF energy.
- The antenna must not be shielded by any metal objects.
- The power supply must be clean and noise-free.
- Make sure that the width of the traces routed to GND, VDD rails are sufficiently large for handling peak TX current consumption.

**Note:** The RNWF02 module includes RF shielding on top of the board as a standard feature.

## 2.6 RNWF02 Module Antenna Considerations

### 2.6.1 PCB Antenna

For the RNWF02PE/PC module, the PCB antenna is fabricated on the top copper layer. The layers below the antenna do not have copper trace. It is recommended that the module be mounted on the edge of the host board and to have no PCB material below the antenna structure of the module and no copper traces or planes on the host board in that area.

The following table lists the technical specification of the PCB antenna when tested with the RNWF02 module mounted on the RNWF02 Add-On Board.

**Table 2-3.** PCB Antenna Specification for RNWF02 Module

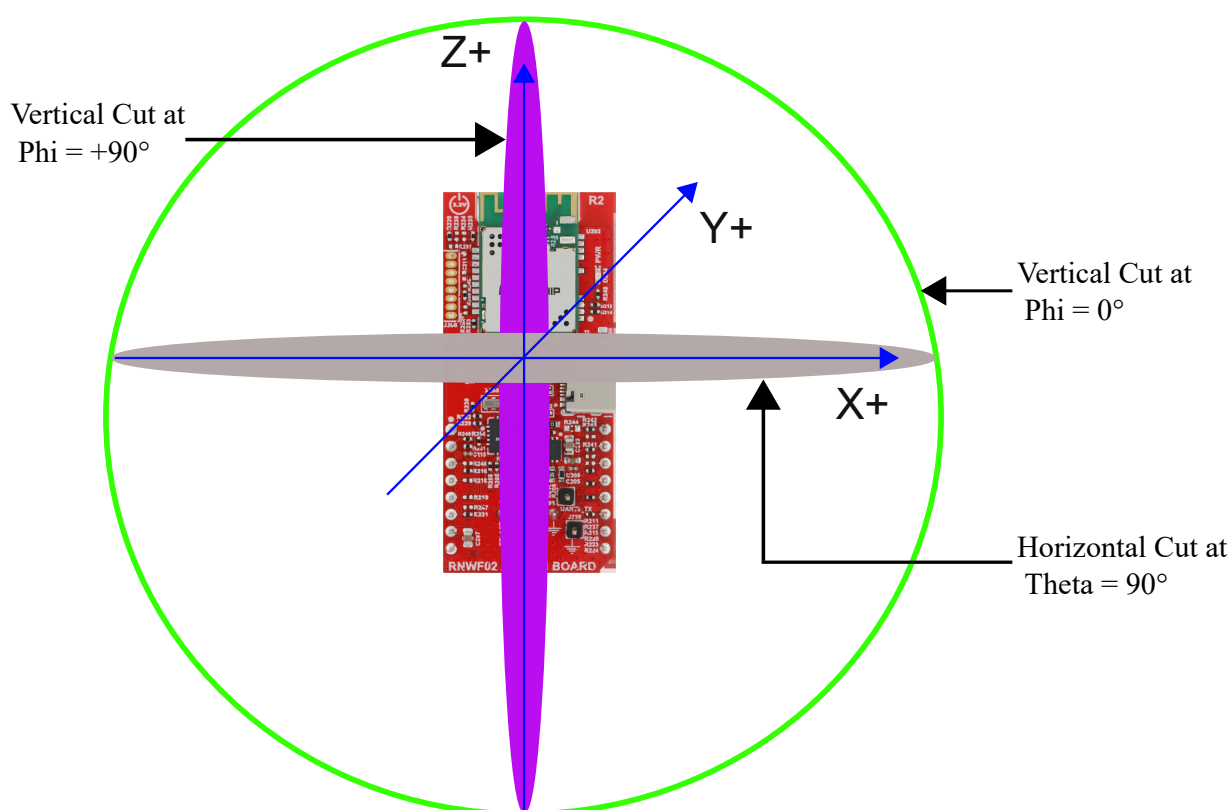
| Parameter            | Specification        |
|----------------------|----------------------|
| Operating frequency  | 2400-2485 MHz        |
| Peak gain            | 1.18 dBi at 2410 MHz |
| Efficiency (average) | 45% <sup>(1)</sup>   |

**Note:**

1. The size of the RNWF02 Add-On Board is 57.2 mm x 25.4 mm. The antenna efficiency will improve with larger ground plane base boards. The same antenna achieved an average efficiency of 69% with a base board size of 85 mm x 40 mm. If the best case routing guidelines are followed on a larger ground plane application board, the efficiency will be better.

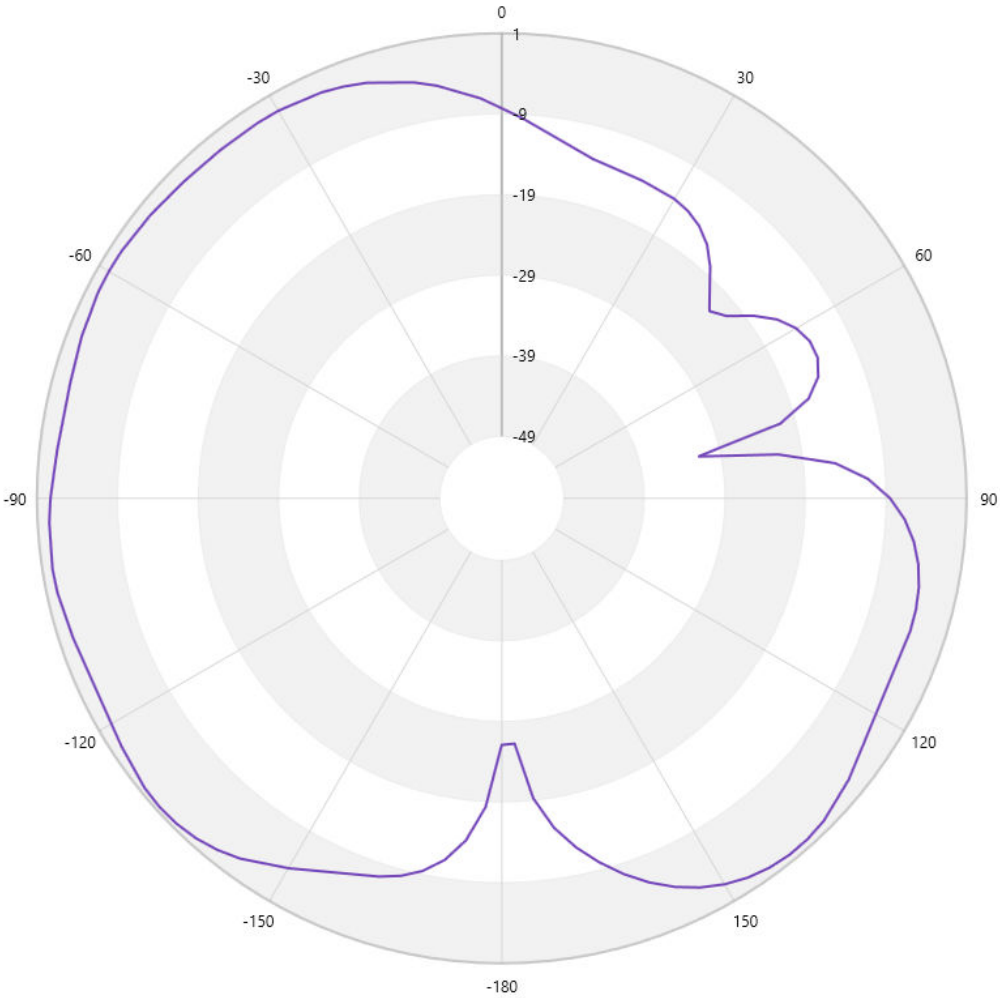
**PCB Antenna Radiation Pattern**

The following figure illustrates the module orientation in the measurement system for the PCB antenna radiation pattern.

**Figure 2-11.** Module Orientation for Radiation Pattern Measurement**Antenna Radiation Pattern**

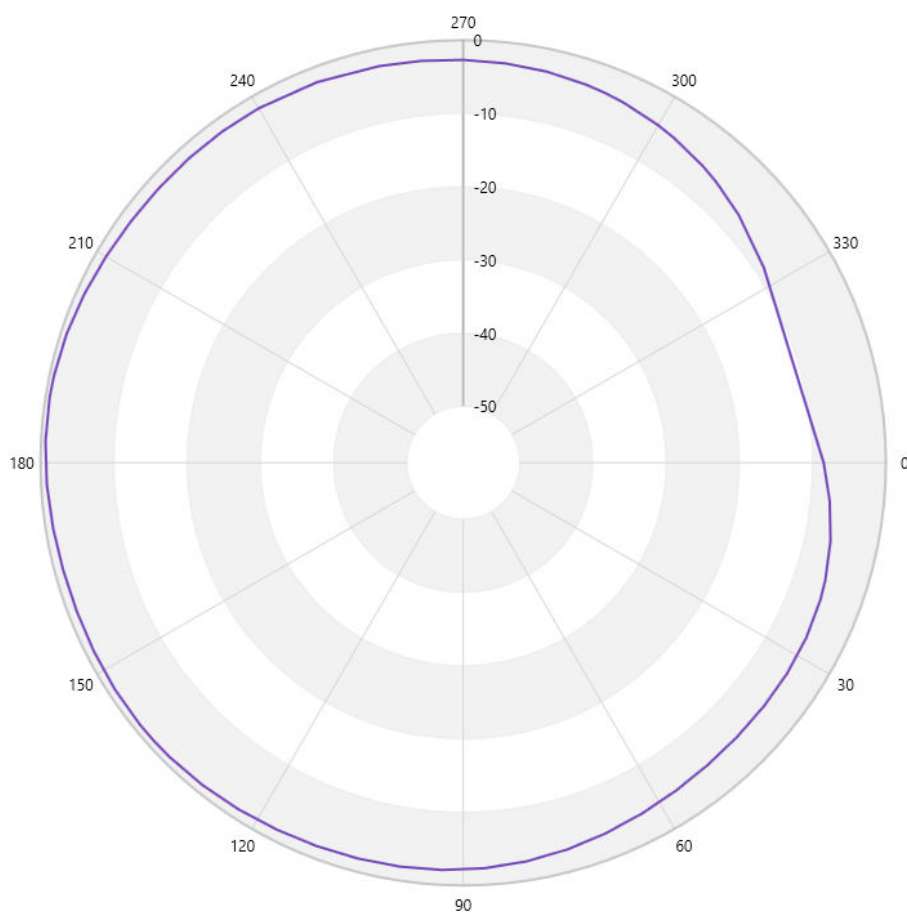
The following figures illustrate the 2D cross section of the antenna radiation pattern.

Figure 2-12. Antenna Radiation Pattern when  $\Phi = 0^\circ$



**Figure 2-13.** Antenna Radiation Pattern when  $\Phi = 90^\circ$



**Figure 2-14.** Antenna Radiation Pattern when Theta = 90°

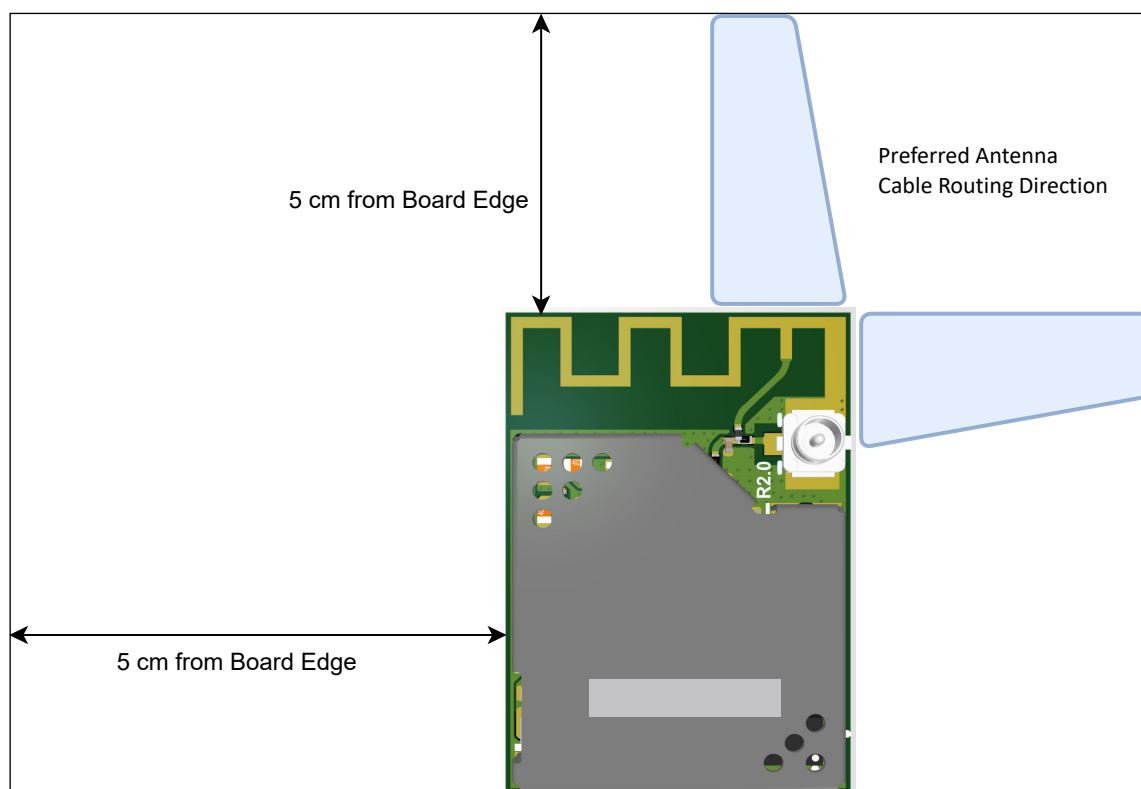
## 2.6.2 External Antenna Placement Recommendations

The user must ensure the following for the placement of the antenna and its cable:

- Do not route the antenna cable over circuits generating electrical noise on the host board or alongside or underneath the module. The recommendation is to route the cable straight out of the module.
- Do not place the antenna in direct contact or in close proximity of the plastic casing/objects.
- Do not enclose the antenna within a metal shield.
- The user must keep any components capable of radiating noise, signals or harmonics in the 2.4-2.5 GHz frequency range away from the antenna and, if feasible, provide shielding for such components. Any noise radiated from the host board in this frequency band degrades the sensitivity of the module.
- Place the antenna at a distance greater than 5 cm away from the module. The following figure illustrates the antenna keepout area (do not place the antenna in this area). This recommendation is based on an open-air measurement and does not take into account any metal shielding of the customer end product. When a metal enclosure is used, the antenna can be located closer to the RNWF02 Module.

The following figure illustrates how the antenna cable must be routed depending on the location of the antenna with respect to the RNWF02 PCB. There are two possible options for the optimum routing of the cable.

**Figure 2-15.** RNWF02 Module Antenna Placement Guidelines



**Note:** These are generic guidelines and the recommendation is that customers can check and fine-tune the antenna positioning in the final host product based on RF performance.

### 2.6.2.1 External Antennas

The RNWF02/UE/UC modules have a small surface mount U.FL connector for an external antenna connection. The choice of antenna is limited to the antenna types that the module is tested and approved for regulatory certification.

The RNWF02/UE/UC modules are approved to use with the antennas listed in the following table. It is permissible to use a different antenna, provided it is the same antenna type, has the same antenna gain (equal or less than) and similar in-band and out-of-band characteristics are present (refer to antenna specification sheet for cutoff frequencies).

If other antenna types are used, the OEM installer must conduct the necessary assessments and authorize the antenna with the respective regulatory agencies and ensure compliance.

**Table 2-4.** Approved External Antenna List with Antenna Gain for RNWF02 Module

| Antenna No. | Part Number        | Manufacturer                            | Antenna Gain (dBi) | Antenna Type | Regulatory Certification       |    |
|-------------|--------------------|-----------------------------------------|--------------------|--------------|--------------------------------|----|
|             |                    |                                         |                    |              | FCC/ISED <sup>(2)</sup><br>(3) | CE |
| 1           | WXE2400            | TE Connectivity/Laird External Antennas | 3                  | Dipole       | x                              | x  |
| 2           | ANT-2.4-CW-RCL-RPS | TE Connectivity/Linx Technologies       | 2.3                | Dipole       | x                              | x  |

.....continued

| Antenna No. | Part Number                       | Manufacturer | Antenna Gain (dBi) | Antenna Type | Regulatory Certification       |    |
|-------------|-----------------------------------|--------------|--------------------|--------------|--------------------------------|----|
|             |                                   |              |                    |              | FCC/ISED <sup>(2)</sup><br>(3) | CE |
| 3           | RFA-02-C2M2-D034                  | Alead        | 2                  | Dipole       | x                              | x  |
| 4           | RFA-02-L2H1 <sup>(5)</sup>        | Aristotle    | 2                  | Dipole       | x                              | x  |
| 5           | RFA-02-C2H1-D034 <sup>(5)</sup>   | Alead        | 2                  | Dipole       | x                              | x  |
| 6           | RFA-02-D3 <sup>(5)</sup>          | Aristotle    | 2                  | Dipole       | x                              | x  |
| 7           | RFDPA870920IMLB301 <sup>(5)</sup> | Walsin       | 1.84               | Dipole       | x                              | x  |
| 8           | RFDPA870920IMAB302 <sup>(5)</sup> | Walsin       | 1.82               | Dipole       | x                              | x  |
| 9           | RFDPA870920IMAB305 <sup>(5)</sup> | Walsin       | 1.82               | Dipole       | x                              | x  |
| 10          | RFDPA870910IMAB308 <sup>(5)</sup> | Walsin       | 2                  | Dipole       | x                              | x  |
| 11          | RFA-02-C2M2 <sup>(5)</sup>        | Aristotle    | 2                  | Dipole       | x                              | x  |
| 12          | RN-SMA-S-RP <sup>(5)</sup>        | Microchip    | 0.56               | Dipole       | x                              | x  |
| 13          | W1049B030 <sup>(5)</sup>          | Pulse        | 2                  | Dipole       | x                              | x  |
| 14          | RN-SMA4-RP <sup>(5)</sup>         | Microchip    | 2.2                | Dipole       | x                              | x  |

**Notes:**

1. 'x' denotes the antennas covered under the certification.
2. If the end product using the module is designed to have an antenna port that is accessible to the end user, a unique (non-standard) antenna connector (as permissible by FCC) must be used (for example, RP (Reverse Polarity)-SMA socket).
3. If an RF coaxial cable is used between the module RF output and the enclosure, a unique (non-standard) antenna connector must be used in the enclosure wall to interface with the antenna.
4. Contact the antenna vendor for detailed antenna specifications to review the suitability to the end product operating environment and to identify alternatives.
5. If any external antenna is used other than the recommended antennas in the list, it may need an extra step of post-calibration on the customer's application board. For more details, refer to the *RNWF02 Module External Antenna Calibration Guide* ([DS50003750](#)).

## 2.7 RNWF02 Module Reflow Profile Information

The RNWF02 module was assembled using the IPC/JEDEC J-STD-020 standard lead-free reflow profile. The RNWF02 module can be soldered to the host board using standard leaded or lead-free solder reflow profiles. To avoid damaging the module, adhere to the following recommendations:

- For solder reflow recommendations, refer to the *AN233 Solder Reflow Recommendation Application Note* ([DS00233](#)).
- Do not exceed a peak temperature (TP) of 250°C.
- For specific reflow profile recommendations from the vendor, refer to the *Solder Paste Data Sheet*.
- Use no-clean flux solder paste.
- Do not wash as moisture can be trapped under the shield.
- Use only one flow. If the PCB requires multiple flows, apply the module on the final flow.

### 2.7.1 Cleaning

The exposed GND pad helps to self-align the module, avoiding pad misalignment. The recommendation is to use the no clean solder pastes. Ensure full drying of no-clean paste fluxes as a result of the reflow process. As per the recommendation by the solder paste vendor, this requires longer reflow profiles and/or peak temperatures toward the high end of the process window. The uncured flux residues can lead to corrosion and/or shorting in accelerated testing and possibly the field.

## 2.8 RNWF02 Module Assembly Considerations

The RNWF02 module is assembled with an Electro-Magnetic Interference (EMI) shield to ensure compliance with EMI emission and immunity rules. The EMI shield is made of a tin-plated steel (SPTE) and is not hermetically sealed. Solutions like IPA and similar solvents can be used to clean the RNWF02 module. However, do not use the cleaning solutions that contain acid on the module.

### 2.8.1 Conformal Coating

The modules are not intended for use with a conformal coating, and the customer assumes all risks (such as the module reliability, performance degradation and so on) if a conformal coating is applied to the modules.

### 3. Electrical Specifications

This chapter provides the electrical specifications and the characteristics of the RNWF02 Module across the operating temperature range of the product.

#### 3.1 RNWF02 Module Absolute Maximum Ratings

The following table provides details about the list of absolute maximum ratings for the RNWF02 module. Exposure to these maximum rating conditions for extended periods can affect the device's reliability. Functional operation of the device at these or any other conditions above the parameters indicated in the operation listings of this specification is not implied.

**Table 3-1.** Absolute Maximum Ratings

| Parameter                                                                                                                                                                                                                                                                                      | Value                              |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------|
| Ambient temperature under bias <sup>(1)</sup>                                                                                                                                                                                                                                                  | -40°C to +85°C                     |
| Storage temperature                                                                                                                                                                                                                                                                            | -65°C to +150°C                    |
| Voltage on V <sub>DD</sub> with respect to GND                                                                                                                                                                                                                                                 | -0.3V to +4.0V                     |
| Voltage on any pin(s) with respect to GND                                                                                                                                                                                                                                                      | -0.3V to (V <sub>DD</sub> +0.3V)   |
| Voltage on (Pin 13-19 and 27) with respect to GND                                                                                                                                                                                                                                              | -0.3V to (V <sub>DDIO</sub> +0.3V) |
| Maximum current out of GND pins <sup>(2)</sup>                                                                                                                                                                                                                                                 | 500 mA                             |
| Maximum current into V <sub>DD</sub> pins <sup>(2)</sup>                                                                                                                                                                                                                                       | 500 mA                             |
| <b>ESD Qualification</b>                                                                                                                                                                                                                                                                       |                                    |
| Human Body Model (HBM) per JESD22-A114                                                                                                                                                                                                                                                         | 2000V                              |
| Charged Device Model (CDM) (ANSI/ESD STM 5.3.1)                                                                                                                                                                                                                                                | ±500V                              |
| <b>Notes:</b>                                                                                                                                                                                                                                                                                  |                                    |
| 1. The preceding table provides the list of stresses that can cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. |                                    |
| 2. Maximum allowable current is a function of the device's maximum power dissipation.                                                                                                                                                                                                          |                                    |

#### 3.2 Thermal Specifications

**Table 3-2.** Thermal Operating Conditions

| Rating                                 | Symbol         | Min. | Typ | Max. | Unit |
|----------------------------------------|----------------|------|-----|------|------|
| <b>Industrial Temperature Devices:</b> |                |      |     |      |      |
| Operating ambient temperature range    | T <sub>A</sub> | -40  | —   | +85  | °C   |
| Operating junction temperature range   | T <sub>J</sub> | -40  | —   | +125 | °C   |

**Table 3-3.** Recommended Operating Voltages

| Param. No. | Symbol            | Characteristics                 | Min.            | Typ.            | Max.            | Unit | Conditions                                                               |
|------------|-------------------|---------------------------------|-----------------|-----------------|-----------------|------|--------------------------------------------------------------------------|
| DC_1       | V <sub>DD</sub>   | V <sub>DD</sub> voltage range   | 3               | 3.3             | 3.6             | V    | —                                                                        |
| DC_4       | V <sub>DDIO</sub> | V <sub>DDIO</sub> voltage range | 1.8             | 3.3             | 3.6             | V    | Module pins (13-19 and 27) only. All other I/Os are at V <sub>DD</sub> . |
| DC_7       | GNDDB             | Common EDP ground reference     | V <sub>SS</sub> | V <sub>SS</sub> | V <sub>SS</sub> | V    | —                                                                        |

### 3.3 RNWF02 Module DC Characteristics

#### 3.3.1 I/O Pin DC Electrical Specifications

**Table 3-4.** I/O Pin DC Electrical Specifications

| DC Characteristics |          |                            | Standard Operating Conditions: $V_{DD} = V_{DDIO} = 3.0V$ to $3.6V$ (unless otherwise stated) |      |                      |         |                   |
|--------------------|----------|----------------------------|-----------------------------------------------------------------------------------------------|------|----------------------|---------|-------------------|
|                    |          |                            | Operating Temperature:<br>$-40^{\circ}C \leq T_A \leq +85^{\circ}C$ for Industrial            |      |                      |         |                   |
| Param. No.         | Symbol   | Characteristics            | Min.                                                                                          | Typ. | Max.                 | Units   | Conditions        |
| DI_1               | $V_{IL}$ | Input low voltage I/O pins | GND                                                                                           | —    | $0.2 \cdot V_{DDIO}$ | V       | —                 |
| DI_3               | $V_{IH}$ | Input high voltage         | $0.8 \cdot V_{DDIO}$                                                                          | —    | $V_{DDIO}$           | V       | —                 |
| DI_5               | $V_{OL}$ | Output low voltage         | —                                                                                             | —    | 0.4                  | V       | —                 |
| DI_9               | $V_{OH}$ | Output high voltage        | 2.4                                                                                           | —    | —                    | V       | $V_{DDIO} = 3.3V$ |
|                    |          | Output high voltage        | 1                                                                                             | —    | —                    | V       | $V_{DDIO} = 1.8V$ |
| DI_13              | $I_{IL}$ | Input pin leakage current  | -1                                                                                            | —    | +1                   | $\mu A$ | —                 |

#### 3.3.2 Wi-Fi® Current Consumption

**Table 3-5.** Wi-Fi® Current Consumption DC Electrical Specifications

| DC Characteristics <sup>(1)(2)</sup> |          |               |                                | Standard Operating Conditions: $V_{DD} = V_{DDIO} = 3.0V$ to $3.6V$ (unless otherwise stated) |                                    |      |       |                            |
|--------------------------------------|----------|---------------|--------------------------------|-----------------------------------------------------------------------------------------------|------------------------------------|------|-------|----------------------------|
|                                      |          |               |                                | Operating Temperature:<br>$-40^{\circ}C \leq T_A \leq +85^{\circ}C$ for Industrial            |                                    |      |       |                            |
| Param. No.                           | Symbol   | Device States | Code Rate                      | Output Power (Typ.) (dBm)                                                                     | Current (Typ.) (mA) <sup>(2)</sup> | Max. | Units | Conditions                 |
| IWF_TX                               | $I_{DD}$ | On_Transmit   | 802.11b 1 Mbps <sup>(4)</sup>  | 19                                                                                            | 304                                | —    | mA    | $V_{DD} = V_{DDIO} = 3.3V$ |
|                                      |          |               | 802.11b 1 Mbps <sup>(4)</sup>  | 13                                                                                            | 270                                | —    |       |                            |
|                                      |          |               | 802.11b 11 Mbps <sup>(3)</sup> | 20                                                                                            | 311                                | —    |       |                            |
|                                      |          |               | 802.11g 6 Mbps <sup>(4)</sup>  | 19                                                                                            | 310                                | —    |       |                            |
|                                      |          |               | 802.11g 54 Mbps <sup>(3)</sup> | 17                                                                                            | 274                                | —    |       |                            |
|                                      |          |               | 802.11n MCS0 <sup>(4)</sup>    | 18                                                                                            | 300                                | —    |       |                            |
|                                      |          |               | 802.11n MCS7 <sup>(3)</sup>    | 17                                                                                            | 273                                | —    |       |                            |
|                                      |          |               | 802.11n MCS7 <sup>(4)</sup>    | 11                                                                                            | 252                                | —    |       |                            |
| IWF_RX                               | $I_{DD}$ | On_Receive    | 802.11b 1 Mbps <sup>(4)</sup>  | —                                                                                             | 92                                 | —    |       |                            |
|                                      |          |               | 802.11n MCS7 <sup>(3)</sup>    | —                                                                                             | 98                                 | —    |       |                            |

**Notes:**

1. Tested on channel 7 using an internal test firmware that provides manual control of data rate. In the Application mode firmware, the data rate is selected automatically based on the RSSI and other variables.
2. Data in the "Typ." column is at 3.3V, 25°C unless otherwise stated.
3. These parameters are tested in manufacturing.
4. These parameters are characterized but not tested in manufacturing.

## 3.4 RNWF02 Module AC Characteristics

### 3.4.1 XOSC32 RTCC Oscillator AC Electrical Specifications

**Table 3-6.** XOSC32 RTCC Oscillator AC Electrical Specifications

| AC Characteristics                                                     |             |                                     | Standard Operating Conditions: $V_{DD} = V_{DDIO} = 3.0V$ to $3.6V$ (unless otherwise stated) |        |      |         |                                              |
|------------------------------------------------------------------------|-------------|-------------------------------------|-----------------------------------------------------------------------------------------------|--------|------|---------|----------------------------------------------|
|                                                                        |             |                                     | Operating Temperature: $-40^{\circ}C \leq T_A \leq +85^{\circ}C$ for Industrial               |        |      |         |                                              |
| Param. No.                                                             | Symbol      | Characteristics                     | Min.                                                                                          | Typ.   | Max. | Units   | Conditions                                   |
| XOSC32_1                                                               | FOSC_XOSC32 | XOSC32 oscillator crystal frequency | —                                                                                             | 32.768 | —    | kHz     | RTCC oscillator                              |
| XOSC32_15                                                              | TOSC32      | $TOSC32 = 1/FOSC\_XOSC32$           | —                                                                                             | —      | —    | $\mu s$ | See parameter XOSC32_1 for FOSC_XOSC32 value |
| XOSC32_21                                                              | XCLK32_DC   | Ext clock oscillator duty cycle     | —                                                                                             | 50     | —    | %       | —                                            |
| <b>Note:</b>                                                           |             |                                     |                                                                                               |        |      |         |                                              |
| 1. These parameters are characterized but not tested in manufacturing. |             |                                     |                                                                                               |        |      |         |                                              |

### 3.4.2 Power on Reset AC Electrical Specifications

**Table 3-7.** Power on Reset AC Electrical Specifications

| AC Characteristics |        |                                                      | Standard Operating Conditions: $V_{DD} = V_{DDIO} = 3.0V$ to $3.6V$ (unless otherwise stated) |      |       |         |                |
|--------------------|--------|------------------------------------------------------|-----------------------------------------------------------------------------------------------|------|-------|---------|----------------|
|                    |        |                                                      | Operating Temperature: $-40^{\circ}C \leq T_A \leq +85^{\circ}C$ for Industrial               |      |       |         |                |
| Param. No.         | Symbol | Characteristics                                      | Min.                                                                                          | Typ. | Max.  | Units   | Conditions     |
| DC_11              | VPOR   | $V_{DD}$ start voltage to ensure internal POR signal | 1.45                                                                                          | —    | 1.65  | V       | —              |
| DC_12              | SVDD   | $V_{DD}$ rise rate to ensure internal POR signal     | 0.03                                                                                          | —    | 0.115 | V/ms    | 0-3.0V in 0.1s |
| DC_13              | TRST   | External Reset valid active pulse width              | 2                                                                                             | —    | —     | $\mu s$ | —              |

## 3.5 RNWF02 Module Radio Specifications

**Table 3-8.** RNWF02 Module Radio Specifications

| Feature            | Description                                        |
|--------------------|----------------------------------------------------|
| WLAN standards     | IEEE® 802.11b, IEEE 802.11g, and IEEE 802.11n      |
| Frequency range    | 2.412 GHz ~ 2.472 GHz (2400 ~ 2483.5 MHz ISM band) |
| Number of channels | 11 for North America and 13 for Europe and Japan   |

### 3.5.1 RNWF02 Module Receiver Performance

**Table 3-9.** RNWF02 Module Receiver Performance Characteristics<sup>(1)</sup>

| RF Characteristics |                 |                            | Standard Operating Conditions: $V_{DD}=V_{DDIO}= 3.0V$ to $3.6V$ (unless otherwise stated) |                    |      |       |
|--------------------|-----------------|----------------------------|--------------------------------------------------------------------------------------------|--------------------|------|-------|
|                    |                 |                            | Operating Temperature: $-40^{\circ}C \leq T_A \leq +85^{\circ}C$ for Industrial            |                    |      |       |
| Param. No.         | Characteristics | Description <sup>(5)</sup> | Min.                                                                                       | Typ <sup>(2)</sup> | Max. | Units |
| WF_RX_1            | Frequency       | —                          | 2412                                                                                       | —                  | 2472 | MHz   |

.....continued

| RF Characteristics |                                                                             |                                             | Standard Operating Conditions: $V_{DD}=V_{DDIO}= 3.0V$ to $3.6V$ (unless otherwise stated) |                    |      |       |
|--------------------|-----------------------------------------------------------------------------|---------------------------------------------|--------------------------------------------------------------------------------------------|--------------------|------|-------|
|                    |                                                                             |                                             | Operating Temperature:<br>$-40^{\circ}C \leq T_A \leq +85^{\circ}C$ for Industrial         |                    |      |       |
| Param. No.         | Characteristics                                                             | Description <sup>(5)</sup>                  | Min.                                                                                       | Typ <sup>(2)</sup> | Max. | Units |
| WF_RX_2            | Sensitivity 802.11b                                                         | 1 Mbps DSSS                                 | —                                                                                          | -97                | —    | dBm   |
|                    |                                                                             | 2 Mbps DSSS                                 | —                                                                                          | -93                | —    |       |
|                    |                                                                             | 5.5 Mbps CCK                                | —                                                                                          | -92                | —    |       |
|                    |                                                                             | 11 Mbps CCK <sup>(6)</sup>                  | —                                                                                          | -88                | —    |       |
| WF_RX_3            | Sensitivity 802.11g                                                         | 6 Mbps OFDM                                 | —                                                                                          | -91                | —    | dBm   |
|                    |                                                                             | 9 Mbps OFDM                                 | —                                                                                          | -90                | —    |       |
|                    |                                                                             | 12 Mbps OFDM                                | —                                                                                          | -88                | —    |       |
|                    |                                                                             | 18 Mbps OFDM                                | —                                                                                          | -86                | —    |       |
|                    |                                                                             | 24 Mbps OFDM                                | —                                                                                          | -83                | —    |       |
|                    |                                                                             | 36 Mbps OFDM                                | —                                                                                          | -80                | —    |       |
|                    |                                                                             | 48 Mbps OFDM                                | —                                                                                          | -75                | —    |       |
|                    |                                                                             | 54 Mbps OFDM <sup>(6)</sup>                 | —                                                                                          | -74                | —    |       |
| WF_RX_4            | Sensitivity 802.11n<br>(Bandwidth at 20 MHz)<br>(Both long GI and short GI) | MCS 0                                       | —                                                                                          | -89                | —    | dBm   |
|                    |                                                                             | MCS 1                                       | —                                                                                          | -86                | —    |       |
|                    |                                                                             | MCS 2                                       | —                                                                                          | -84                | —    |       |
|                    |                                                                             | MCS 3                                       | —                                                                                          | -81                | —    |       |
|                    |                                                                             | MCS 4                                       | —                                                                                          | -78                | —    |       |
|                    |                                                                             | MCS 5                                       | —                                                                                          | -74                | —    |       |
|                    |                                                                             | MCS 6                                       | —                                                                                          | -72                | —    |       |
|                    |                                                                             | MCS 7 <sup>(6)</sup>                        | —                                                                                          | -70                | —    |       |
| WF_RX_5            | Maximum receive signal level                                                | 1, 2 Mbps DSSS                              | -3                                                                                         | —                  | —    | dBm   |
|                    |                                                                             | 5.5, 11 Mbps CCK                            | -3                                                                                         | —                  | —    |       |
|                    |                                                                             | 6 Mbps OFDM                                 | -3                                                                                         | —                  | —    |       |
|                    |                                                                             | 54 Mbps OFDM                                | -8.5                                                                                       | —                  | —    |       |
|                    |                                                                             | MCS 0                                       | -3                                                                                         | —                  | —    |       |
|                    |                                                                             | MCS 7                                       | -8.5                                                                                       | —                  | —    |       |
| WF_RX_6            | Adjacent channel rejection                                                  | 1 Mbps DSSS<br>(30 MHz offset)              | 43.5                                                                                       | —                  | —    | dB    |
|                    |                                                                             | 11 Mbps CCK<br>(25 MHz offset)              | 38.5                                                                                       | —                  | —    |       |
|                    |                                                                             | 6 Mbps OFDM<br>(25 MHz offset)              | 46.5                                                                                       | —                  | —    |       |
|                    |                                                                             | 54 Mbps OFDM<br>(25 MHz offset)             | 28.5                                                                                       | —                  | —    |       |
|                    |                                                                             | MCS 0 – 20 MHz Bandwidth<br>(25 MHz offset) | 45.5                                                                                       | —                  | —    |       |
|                    |                                                                             | MCS 7 – 20 MHz Bandwidth<br>(25 MHz offset) | 25.5                                                                                       | —                  | —    |       |
|                    |                                                                             |                                             |                                                                                            |                    |      |       |
|                    |                                                                             |                                             |                                                                                            |                    |      |       |
| WF_RX_7            | RSSI accuracy                                                               | —                                           | -5                                                                                         | —                  | 5    | dB    |

.....continued

| RF Characteristics                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                 |                            | Standard Operating Conditions: $V_{DD}=V_{DDIO}= 3.0V$ to $3.6V$ (unless otherwise stated)<br>Operating Temperature:<br>$-40^{\circ}C \leq T_A \leq +85^{\circ}C$ for Industrial |                    |      |       |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|----------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------|------|-------|
| Param. No.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | Characteristics | Description <sup>(5)</sup> | Min.                                                                                                                                                                             | Typ <sup>(2)</sup> | Max. | Units |
| <b>Notes:</b><br>1. Measured after RF matching network (assume 50Ω impedance)<br>2. RF performance is ensured at 3.3V, 25°C, with a 2-3 dB change at boundary conditions.<br>3. The availability of some specific channels and/or operational frequency bands are country-dependent and must be programmed in the host product at the factory to match the intended destination. Regulatory bodies prohibit exposing the settings to the end user. This requirement needs to be taken care of via host implementation.<br>4. The host product manufacturer must ensure that the RF behavior adheres to the certification (for example, FCC, ISDE) requirements when the module is installed in the final host product.<br>5. This parameter is characterized but not tested in manufacturing.<br>6. This parameter is characterized and tested in manufacturing. |                 |                            |                                                                                                                                                                                  |                    |      |       |

### 3.5.2 RNWF02 Module Transmitter Performance

**Table 3-10.** RNWF02 Module Transmitter Performance Characteristics

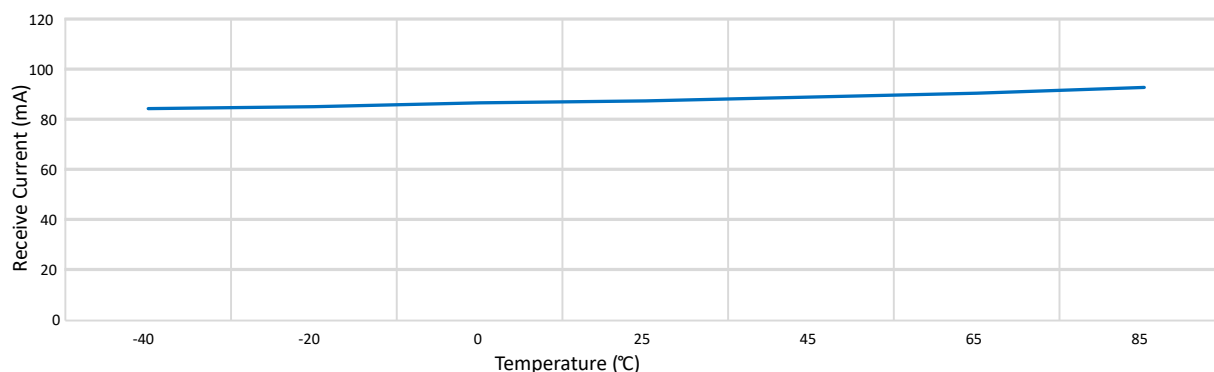
| RF Characteristics |                                                                 |                             | Standard Operating Conditions: $V_{DD}=V_{DDIO}= 3.0V$ to $3.6V$ (unless otherwise stated)<br>Operating Temperature:<br>$-40^{\circ}C \leq T_A \leq +85^{\circ}C$ for Industrial |                    |      |       |
|--------------------|-----------------------------------------------------------------|-----------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------|------|-------|
| Param. No.         | Characteristics                                                 | Description <sup>(8)</sup>  | Min.                                                                                                                                                                             | Typ <sup>(3)</sup> | Max. | Units |
| WF_TX_1            | Frequency                                                       | —                           | 2412                                                                                                                                                                             | —                  | 2472 | MHz   |
| WF_TX_2            | Output power <sup>(1)(2)</sup> 802.11b                          | 1 Mbps DSSS <sup>(9)</sup>  | —                                                                                                                                                                                | 19                 | —    | dBm   |
|                    |                                                                 | 2 Mbps DSSS                 | —                                                                                                                                                                                | 19                 | —    |       |
|                    |                                                                 | 5.5 Mbps CCK                | —                                                                                                                                                                                | 20                 | —    |       |
|                    |                                                                 | 11 Mbps CCK                 | —                                                                                                                                                                                | 20                 | —    |       |
| WF_TX_3            | Output power <sup>(1)(2)</sup> 802.11g                          | 6 Mbps OFDM                 | —                                                                                                                                                                                | 19                 | —    | dBm   |
|                    |                                                                 | 9 Mbps OFDM                 | —                                                                                                                                                                                | 19                 | —    |       |
|                    |                                                                 | 12 Mbps OFDM                | —                                                                                                                                                                                | 19                 | —    |       |
|                    |                                                                 | 18 Mbps OFDM                | —                                                                                                                                                                                | 19                 | —    |       |
|                    |                                                                 | 24 Mbps OFDM                | —                                                                                                                                                                                | 19                 | —    |       |
|                    |                                                                 | 36 Mbps OFDM                | —                                                                                                                                                                                | 18                 | —    |       |
|                    |                                                                 | 48 Mbps OFDM                | —                                                                                                                                                                                | 17.5               | —    |       |
|                    |                                                                 | 54 Mbps OFDM <sup>(9)</sup> | —                                                                                                                                                                                | 17                 | —    |       |
| WF_TX_4            | Output power <sup>(1)(2)</sup> 802.11n<br>(Bandwidth at 20 MHz) | MCS 0                       | —                                                                                                                                                                                | 18                 | —    | dBm   |
|                    |                                                                 | MCS 1                       | —                                                                                                                                                                                | 18                 | —    |       |
|                    |                                                                 | MCS 2                       | —                                                                                                                                                                                | 18                 | —    |       |
|                    |                                                                 | MCS 3                       | —                                                                                                                                                                                | 17.5               | —    |       |
|                    |                                                                 | MCS 4                       | —                                                                                                                                                                                | 17.5               | —    |       |
|                    |                                                                 | MCS 5                       | —                                                                                                                                                                                | 17                 | —    |       |
|                    |                                                                 | MCS 6                       | —                                                                                                                                                                                | 17                 | —    |       |
|                    |                                                                 | MCS 7 <sup>(9)</sup>        | —                                                                                                                                                                                | 17                 | —    |       |
| WF_TX_5            | Transmit Power Control (TPC) accuracy                           | —                           | —                                                                                                                                                                                | ±2 <sup>(2)</sup>  | —    | dB    |

.....continued

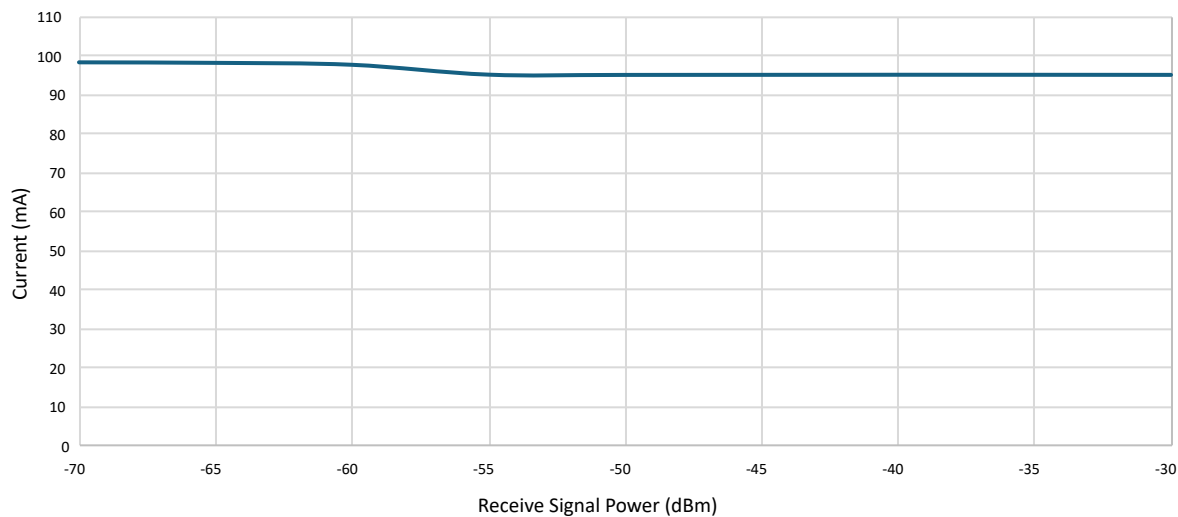
| RF Characteristics                                                                                                                                                                                                                                                                                                                        |                                                   |                            | Standard Operating Conditions: V <sub>DD</sub> =V <sub>DDIO</sub> = 3.0V to 3.6V (unless otherwise stated) |                    |                   |        |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------|----------------------------|------------------------------------------------------------------------------------------------------------|--------------------|-------------------|--------|
|                                                                                                                                                                                                                                                                                                                                           |                                                   |                            | Operating Temperature:<br>-40°C ≤ T <sub>A</sub> ≤ +85°C for Industrial                                    |                    |                   |        |
| Param. No.                                                                                                                                                                                                                                                                                                                                | Characteristics                                   | Description <sup>(8)</sup> | Min.                                                                                                       | Typ <sup>(3)</sup> | Max.              | Units  |
| WF_TX_6                                                                                                                                                                                                                                                                                                                                   | Harmonic output power (Radiated, Regulatory mode) | 2nd                        | —                                                                                                          | 42                 | 74 <sup>(7)</sup> | dBuV/m |
|                                                                                                                                                                                                                                                                                                                                           |                                                   | 3rd                        | —                                                                                                          | Below noise floor  | 74 <sup>(7)</sup> |        |
| Notes:                                                                                                                                                                                                                                                                                                                                    |                                                   |                            |                                                                                                            |                    |                   |        |
| 1. Measured at IEEE® 802.11 specification compliant EVM/Spectral mask                                                                                                                                                                                                                                                                     |                                                   |                            |                                                                                                            |                    |                   |        |
| 2. Measured after RF matching network (assume 50Ω impedance)                                                                                                                                                                                                                                                                              |                                                   |                            |                                                                                                            |                    |                   |        |
| 3. RF performance is ensured at 3.3V, 25°C, with a 2-3 dB change at boundary conditions.                                                                                                                                                                                                                                                  |                                                   |                            |                                                                                                            |                    |                   |        |
| 4. With respect to TX power, different (higher/lower) RF output power settings can be used for specific antennas and/or enclosures, in which case, re-certification can be required. Program the custom gain table to control the transmit power using the MCHPRT3 tool.                                                                  |                                                   |                            |                                                                                                            |                    |                   |        |
| 5. The availability of some specific channels and/or operational frequency bands are country-dependent and must be programmed in the host product at the factory to match the intended destination. Regulatory bodies prohibit exposing the settings to the end user. This requirement needs to be taken care of via host implementation. |                                                   |                            |                                                                                                            |                    |                   |        |
| 6. The host product manufacturer must ensure that the RF behavior adheres to the certification (for example, FCC, ISSED) requirements when the module is installed in the final host product.                                                                                                                                             |                                                   |                            |                                                                                                            |                    |                   |        |
| 7. FCC Radiated Emission limits (Restricted Band)                                                                                                                                                                                                                                                                                         |                                                   |                            |                                                                                                            |                    |                   |        |
| 8. This parameter is characterized but not tested in manufacturing.                                                                                                                                                                                                                                                                       |                                                   |                            |                                                                                                            |                    |                   |        |
| 9. This parameter is characterized and tested in manufacturing.                                                                                                                                                                                                                                                                           |                                                   |                            |                                                                                                            |                    |                   |        |

### 3.5.3 RNWF02 Module Receiver and Transmitter Characteristics Graphs

**Figure 3-1.** Receive Current vs Temperature, MCS7, Channel 7, 3.3V



**Figure 3-2.** Receive Current vs Receive Signal Power, MCS7, Channel 7, 3.3V, 25°C



**Figure 3-3.** Transmit Current vs Temperature, MCS7, Channel 7, 3.3V

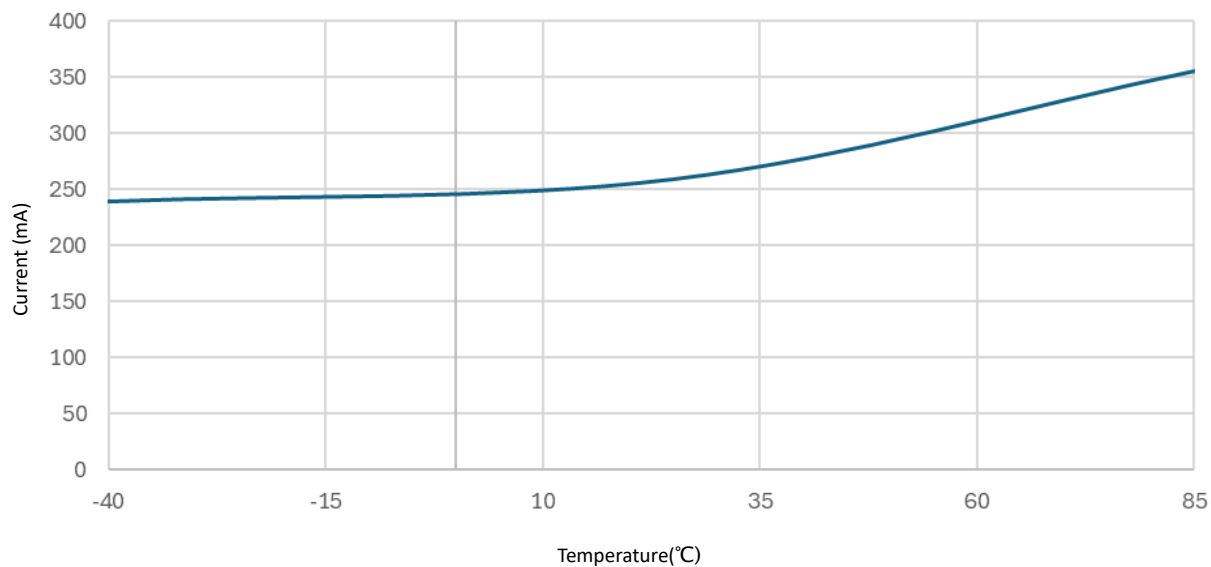


Figure 3-4. Transmit Current vs Transmit Output Power, MCS7, Channel 7, 3.3V, 25°C

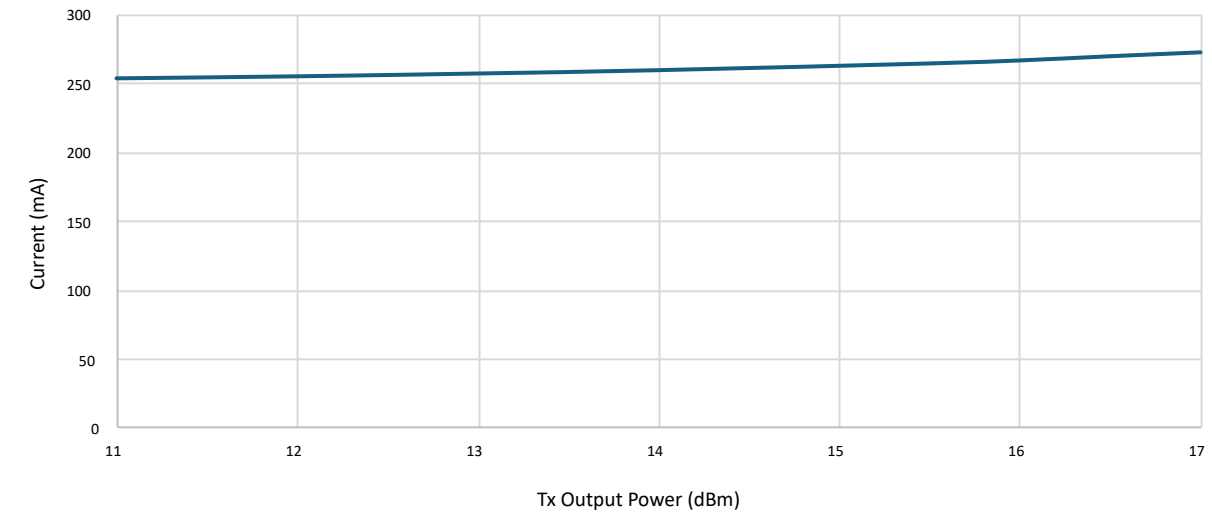


Figure 3-5. Transmit Power vs Voltage, 1M, Channel 7, 3.3V, 25°C

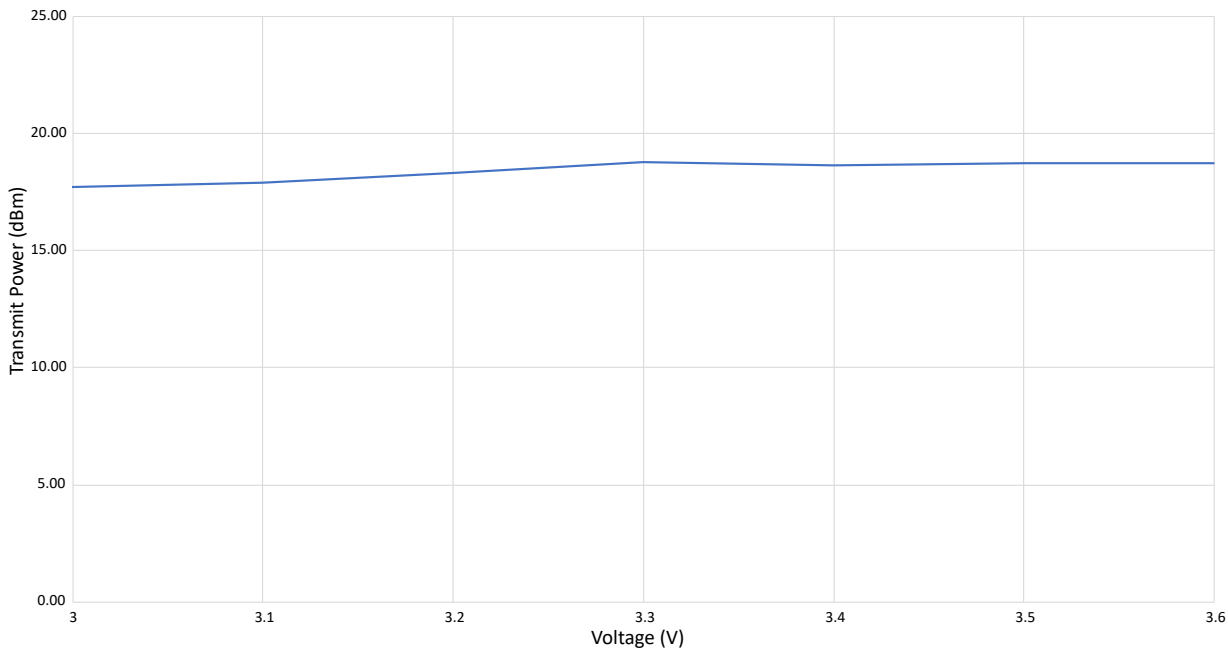


Figure 3-6. Transmit Power vs Temperature, 1M, Channel 7, 3.3V

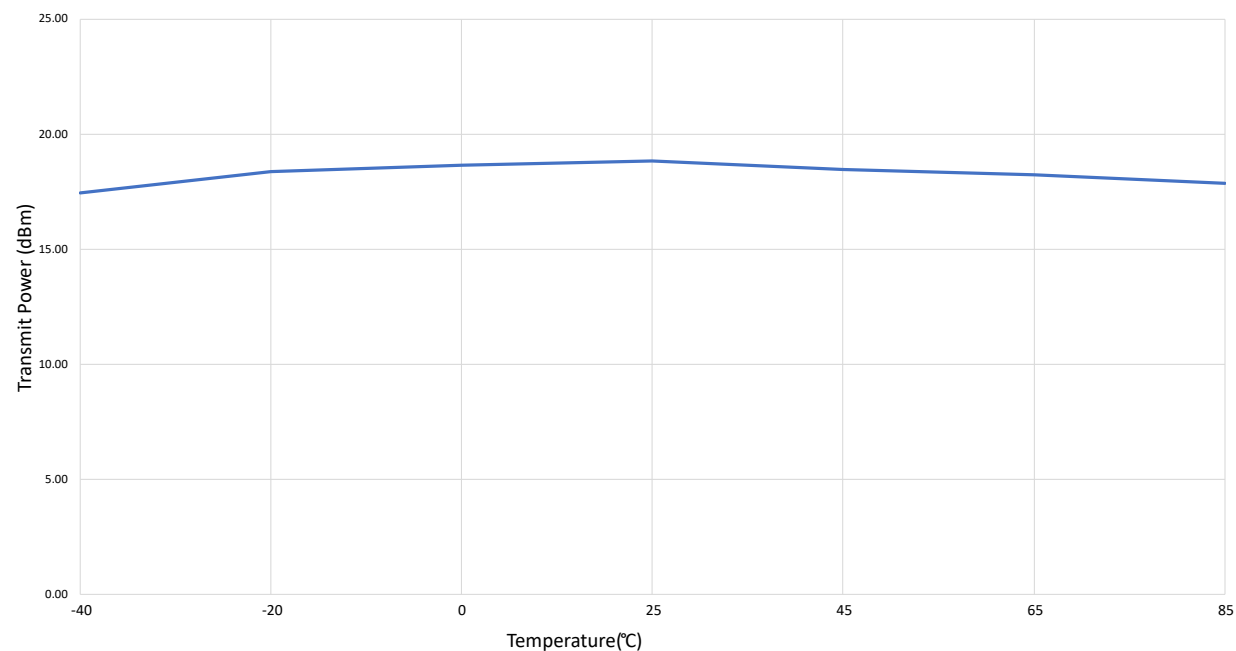
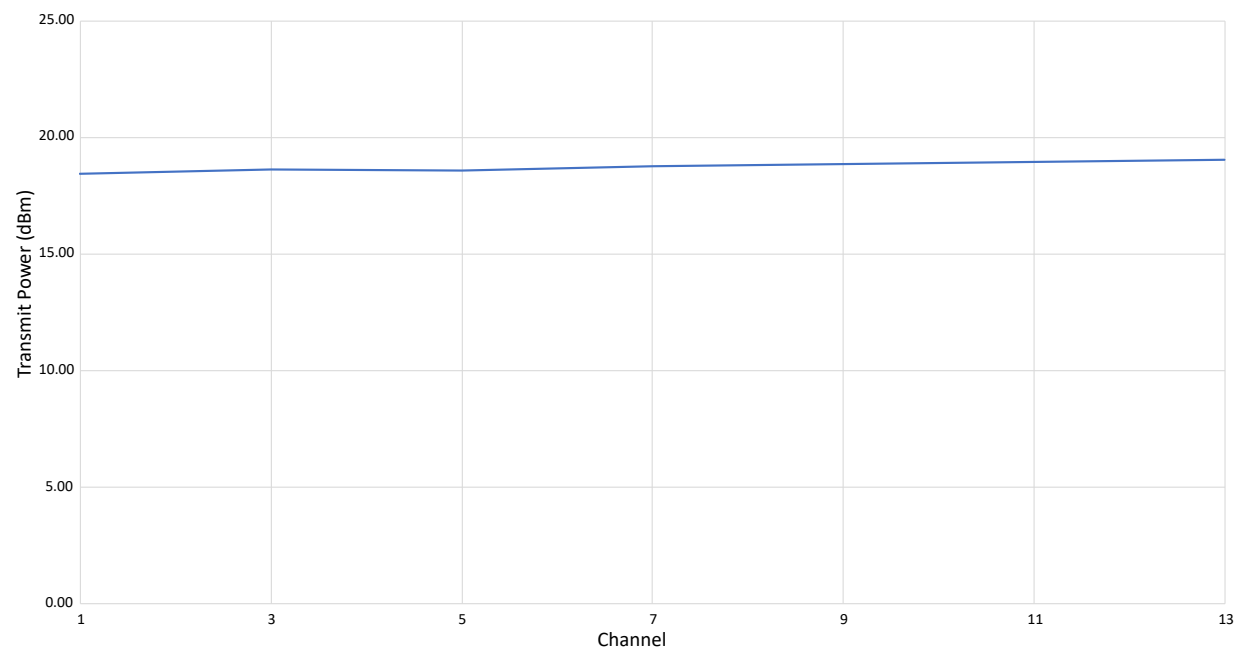
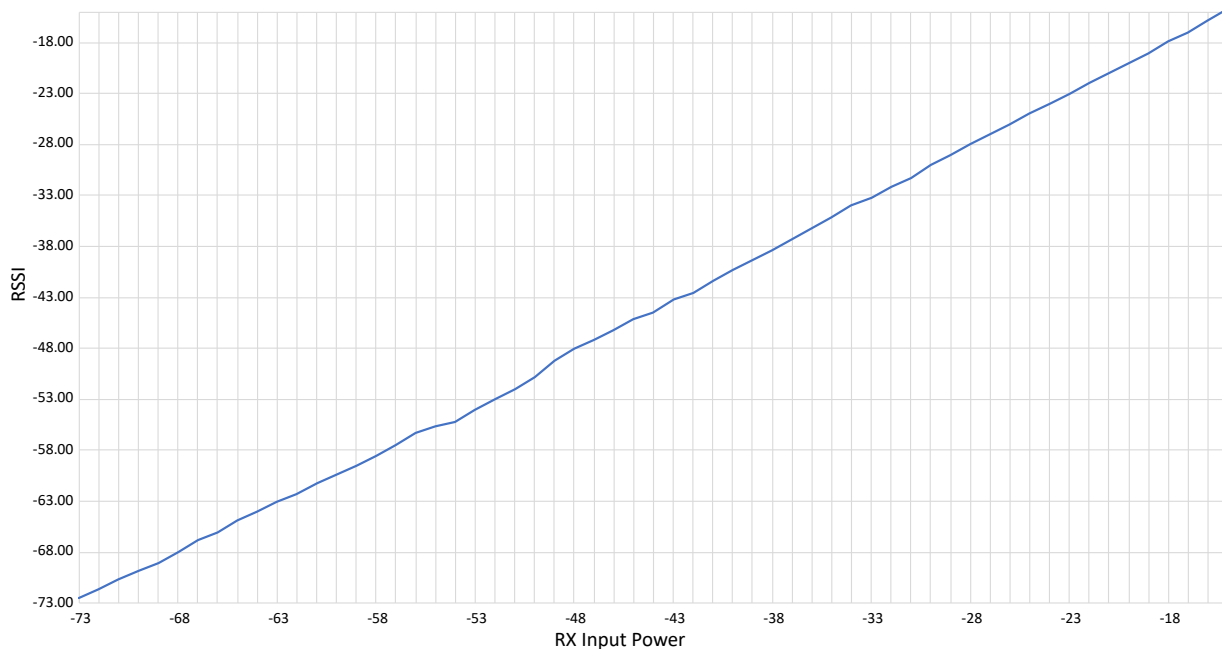


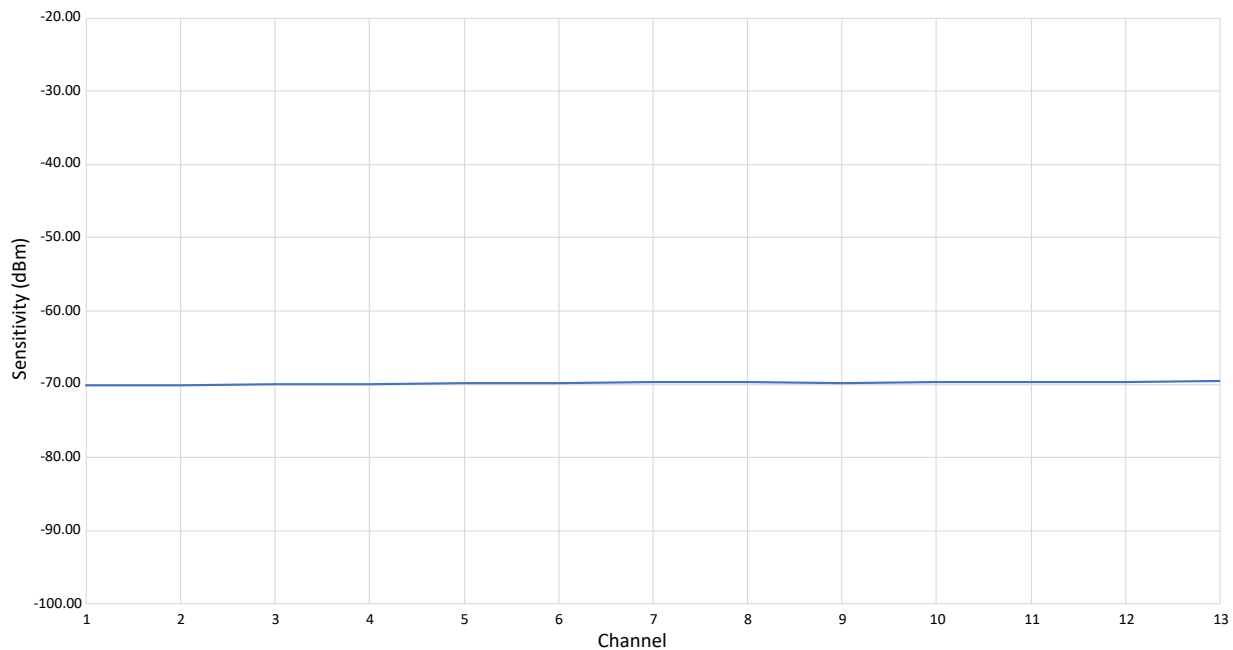
Figure 3-7. Transmit Power vs Channel, 1M, Channel 7, 3.3V, 25°C



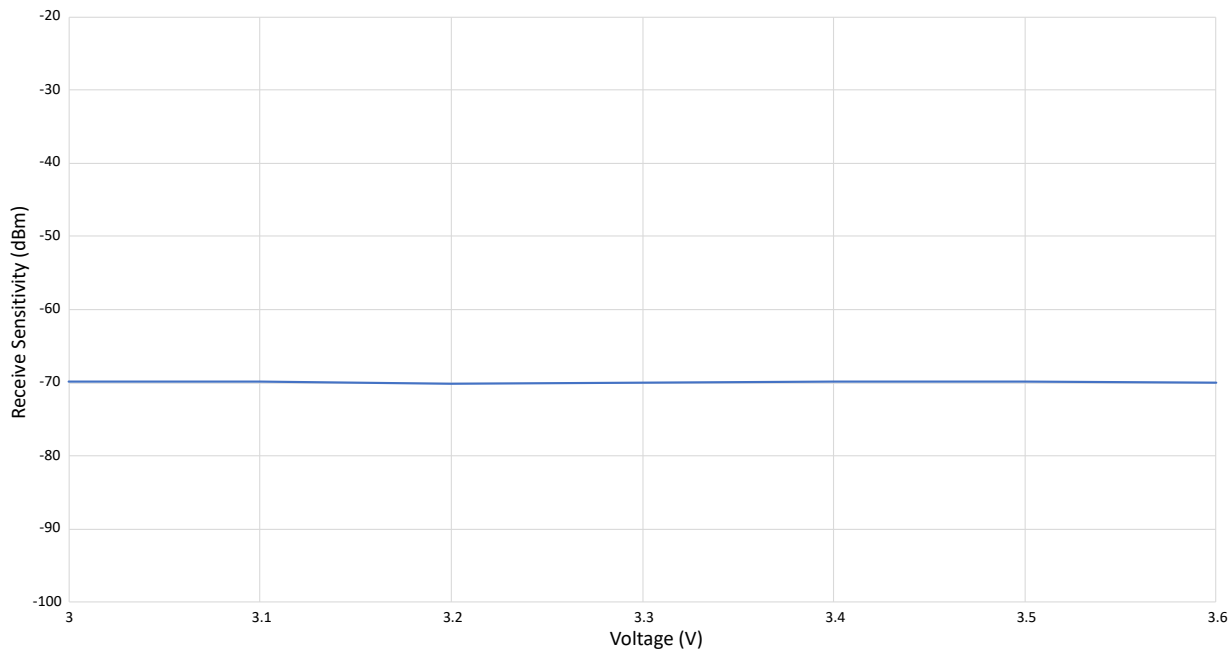
**Figure 3-8.** RX RSSI vs RX Input Power, MCS7, 3.3V, 25°C



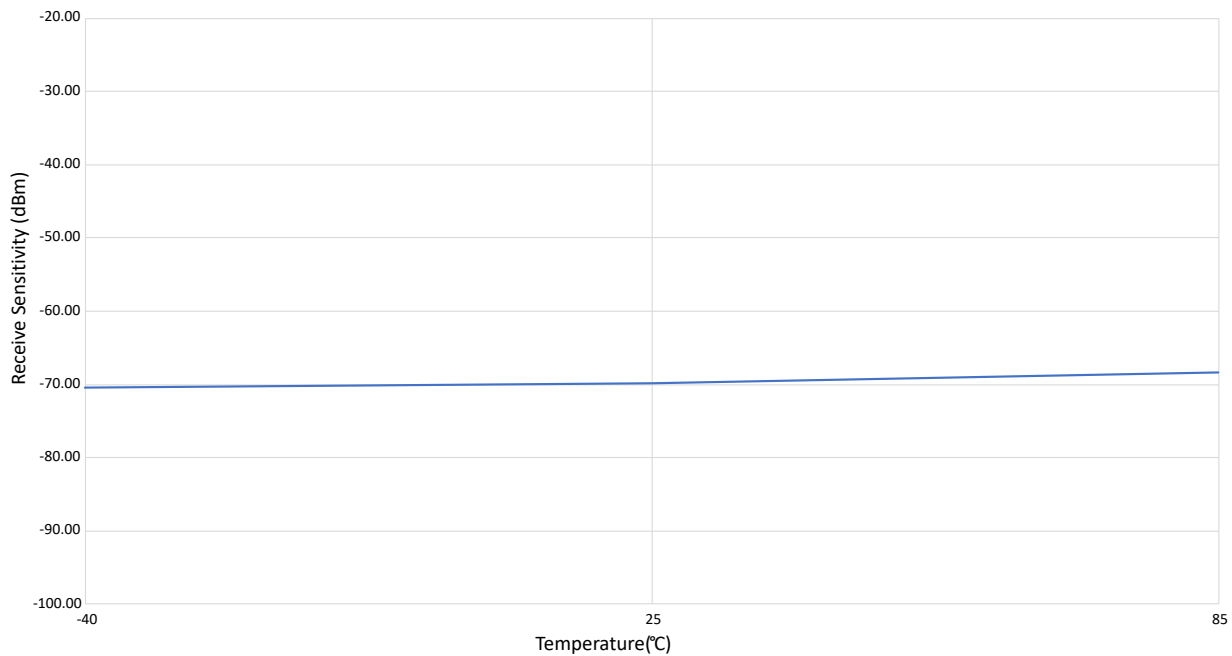
**Figure 3-9.** RX Sensitivity vs Channel, MCS7, 3.3V, 25°C



**Figure 3-10.** Receive Sensitivity vs Voltage, MCS7, Channel 7, 3.3V, 25°C



**Figure 3-11.** Receive Sensitivity vs Temperature, MCS7, Channel 7, 3.3V



## 4. RNWF02 Module Packaging Information

### 4.1 RNWF02 Module Packaging Marking

Figure 4-1. RNWF02 Module Packaging Marking



**Legend:**

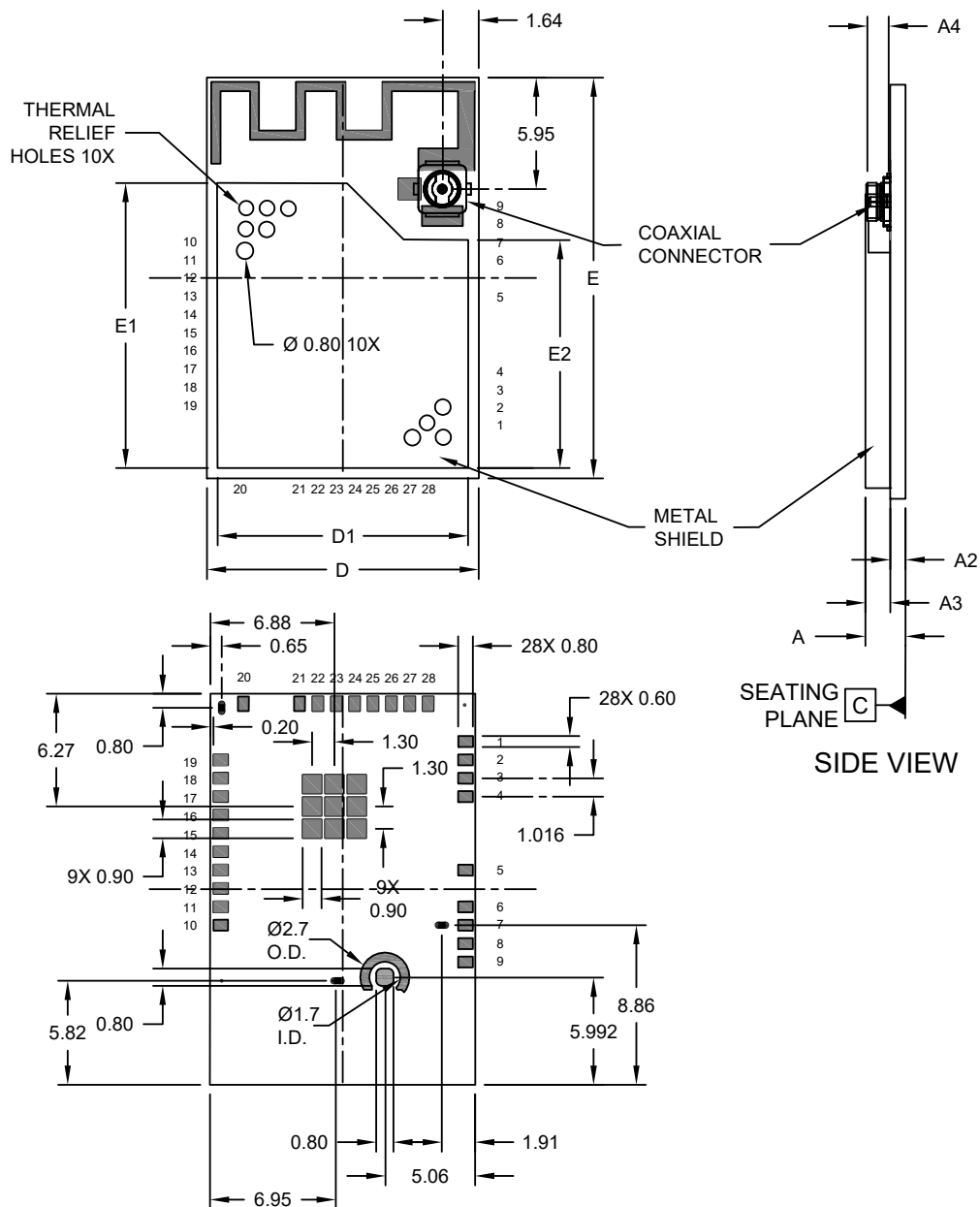
|         |                                                          |
|---------|----------------------------------------------------------|
| XX....X | Module part number and version and regulatory designator |
| YY:     | Year code (last 2 digits of calendar year)               |
| WW      | Week code (week of January 1 is week "01")               |
| NNN     | Alphanumeric traceability code                           |

### 4.2 RNWF02 Module Packaging Dimension

This section provides the package dimension details of the RNWF02 module.

## 28-Lead PCB Module (TEC) - 14.73x21.72x2.1 mm Body [MODULE] With Metal Shield and Coaxial Connector

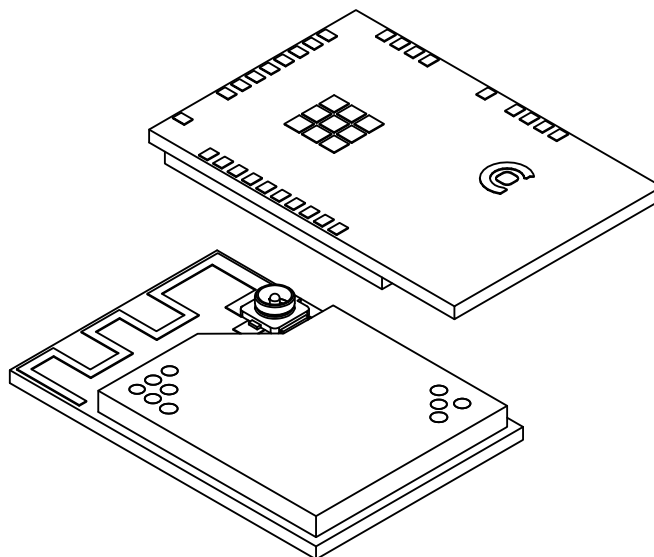
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Microchip Technology Drawing C04-21567 Rev C Sheet 1 of 2

## 28-Lead PCB Module (TEC) - 14.73x21.72x2.1 mm Body [MODULE] With Metal Shield and Coaxial Connector

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



|                      |    | Units | MILLIMETERS |       |       |
|----------------------|----|-------|-------------|-------|-------|
| Dimension Limits     |    |       | MIN         | NOM   | MAX   |
| Number of Terminals  | N  |       | 28          |       |       |
| Overall Height       | A  |       | 1.90        | 2.10  | 2.30  |
| PCB Thickness        | A2 |       | 0.70        | 0.80  | 0.90  |
| Shield Height        | A3 |       | 1.30 REF    |       |       |
| UFL Connector Height | A4 |       | 1.25 REF    |       |       |
| Overall Length       | D  |       | 14.73 BSC   |       |       |
| Overall Width        | E  |       | 21.72 BSC   |       |       |
| Shield Length        | D1 |       | 13.53       | 13.63 | 13.73 |
| Shield Width         | E1 |       | 15.36       | 15.46 | 15.56 |
| Terminal Width       | b  |       | 0.50        | 0.60  | 0.70  |
| Terminal Length      | L  |       | 0.70        | 0.80  | 0.90  |
| Shield Width 2       | E2 |       | 12.30       | 12.40 | 12.50 |

**Notes:**

1. All dimensions are in millimeters.

Microchip Technology Drawing C04-21567 Rev C Sheet 2 of 2

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



1. All dimensions are in millimeters.
2. Keep these areas free from routes and exposed copper. Ground fill with solder mask may be placed here.



## 5. Appendix A: Regulatory Approval

The RNWF02PC module has received regulatory approval for the following countries:

- United States/FCC ID: 2ADHKWIXCS02
- Canada/ISED:
  - IC: 20266-WIXCS02
  - HVIN: RNWF02PC
  - PMN:Wireless MCU Module with IEEE®802.11 b/g/n
- Europe/CE
- Great Britain/UKCA

The RNWF02PE module has received regulatory approval for the following countries:

- United States/FCC ID: 2ADHKWIXCS02
- Canada/ISED:
  - IC: 20266-WIXCS02
  - HVIN: RNWF02PE
  - PMN:Wireless MCU Module with IEEE®802.11 b/g/n
- Europe/CE
- Great Britain/UKCA

The RNWF02UC module has received regulatory approval for the following countries:

- United States/FCC ID: 2ADHKWIXCS02U
- Canada/ISED:
  - IC: 20266-WIXCS02U
  - HVIN: RNWF02UC
  - PMN:Wireless MCU Module with IEEE®802.11 b/g/n
- Europe/CE
- Great Britain/UKCA

The RNWF02UE module has received regulatory approval for the following countries:

- United States/FCC ID: 2ADHKWIXCS02U
- Canada/ISED:
  - IC: 20266-WIXCS02U
  - HVIN: RNWF02UE
  - PMN:Wireless MCU Module with IEEE®802.11 b/g/n
- Europe/CE
- Great Britain/UKCA

### 5.1 United States

The RNWF02PC/RNWF02PE/RNWF02UC/RNWF02UE modules have received Federal Communications Commission (FCC) CFR47 Telecommunications, Part 15 Subpart C “Intentional Radiators” single-modular approval in accordance with Part 15.212 Modular Transmitter approval. Single-modular transmitter approval is defined as a complete RF transmission sub-assembly, designed to be incorporated into another device, that must demonstrate compliance with FCC rules and policies independent of any host. A transmitter with a modular grant can be installed in different end-use products (referred to as a host, host product or host device) by the grantee or other equipment manufacturer, then the host product may not require additional testing or

equipment authorization for the transmitter function provided by that specific module or limited module device.

The user must comply with all of the instructions provided by the Grantee, which indicate installation and/or operating conditions necessary for compliance.

A host product itself is required to comply with all other applicable FCC equipment authorization regulations, requirements, and equipment functions that are not associated with the transmitter module portion. For example, compliance must be demonstrated: to regulations for other transmitter components within a host product; to requirements for unintentional radiators (Part 15 Subpart B), such as digital devices, computer peripherals, radio receivers, etc.; and to additional authorization requirements for the non-transmitter functions on the transmitter module (i.e., Suppliers Declaration of Conformity (SDoC) or certification) as appropriate (e.g., Bluetooth and Wi-Fi transmitter modules may also contain digital logic functions).

### 5.1.1 Labeling and User Information Requirements

The RNWF02PC/RNWF02PE/RNWF02UC/RNWF02UE modules have been labeled with its own FCC ID number, and if the FCC ID is not visible when the module is installed inside another device, then the outside of the finished product into which the module is installed must display a label referring to the enclosed module. This exterior label must use the following wording:

|                            |                                                                                                                                                                                                                                                                                                                                                                                                      |
|----------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| For the RNWF02PC/PE module | <p>Contains Transmitter Module FCC ID: 2ADHKWIXCS02<br/>or<br/>Contains FCC ID: 2ADHKWIXCS02</p> <p><b>This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.</b></p>   |
| For the RNWF02UC/UE module | <p>Contains Transmitter Module FCC ID: 2ADHKWIXCS02U<br/>or<br/>Contains FCC ID: 2ADHKWIXCS02U</p> <p><b>This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.</b></p> |

The user's manual for the finished product must include the following statement:

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy, and if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna
- Increase the separation between the equipment and receiver
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected
- Consult the dealer or an experienced radio/TV technician for help

Additional information on labeling and user information requirements for Part 15 devices can be found in KDB Publication 784748, which is available at the FCC Office of Engineering and Technology (OET) Laboratory Division Knowledge Database (KDB) [apps.fcc.gov/oetcf/kdb/index.cfm](https://apps.fcc.gov/oetcf/kdb/index.cfm).

### 5.1.2 RF Exposure

All transmitters regulated by FCC must comply with RF exposure requirements. KDB 447498 General RF Exposure Guidance provides guidance in determining whether proposed or existing transmitting

facilities, operations or devices comply with limits for human exposure to Radio Frequency (RF) fields adopted by the Federal Communications Commission (FCC).

From the FCC Grant: Output power listed is conducted. This grant is valid only when the module is sold to OEM integrators and must be installed by the OEM or OEM integrators. This transmitter is restricted for use with the specific antenna(s) tested in this application for Certification and must not be co-located or operating in conjunction with any other antenna or transmitters within a host device, except in accordance with FCC multi-transmitter product procedures.

RNWF02PC/RNWF02PE/RNWF02UC/RNWF02UE: These modules are approved for installation into mobile or/and portable host platforms.

### 5.1.3 Approved Antenna Types

To maintain modular approval in the United States, only the antenna types that have been tested shall be used. It is permissible to use different antenna, provided the same antenna type, antenna gain (equal to or less than), with similar in-band and out-of band characteristics (refer to specification sheet for cutoff frequencies).

For the RNWF02PC/PE, the approval is received using the integral PCB antenna.

For the RNWF02UC/UE, approved antennas are listed in the [Table 2-4](#).

### 5.1.4 Helpful Web Sites

- Federal Communications Commission (FCC): [www.fcc.gov](http://www.fcc.gov).
- FCC Office of Engineering and Technology (OET) Laboratory Division Knowledge Database (KDB) [apps.fcc.gov/oetcf/kdb/index.cfm](https://apps.fcc.gov/oetcf/kdb/index.cfm).

## 5.2 Canada

The RNWF02PC/RNWF02PE/RNWF02UC/RNWF02UE modules have been certified for use in Canada under Innovation, Science and Economic Development Canada (ISED, formerly Industry Canada) Radio Standards Procedure (RSP) RSP-100, Radio Standards Specification (RSS) RSS-Gen and RSS-247. Modular approval permits the installation of a module in a host device without the need to recertify the device.

### 5.2.1 Labeling and User Information Requirements

Labeling Requirements (from RSP-100 - Issue 12, Section 5): The host product shall be properly labeled to identify the module within the host device.

The Innovation, Science and Economic Development Canada certification label of a module shall be clearly visible at all times when installed in the host device; otherwise, the host product must be labeled to display the Innovation, Science and Economic Development Canada certification number of the module, preceded by the word "Contains" or similar wording expressing the same meaning, as follows:

|                                  |                                    |
|----------------------------------|------------------------------------|
| For the RNWF02PC/RNWF02PE module | <b>Contains IC: 20266-WIXCS02</b>  |
| For the RNWF02UC/RNWF02UE module | <b>Contains IC: 20266-WIXCS02U</b> |

User Manual Notice for License-Exempt Radio Apparatus (from Section 8.4 RSS-Gen, Issue 5, February 2021): User manuals for license-exempt radio apparatus shall contain the following or equivalent notice in a conspicuous location in the user manual or alternatively on the device or both:

This device contains license-exempt transmitter(s)/receiver(s) that comply with Innovation, Science and Economic Development Canada's license-exempt RSS(s). Operation is subject to the following two conditions:

(1) This device may not cause interference;

(2) This device must accept any interference, including interference that may cause undesired operation of the device.

L'émetteur/récepteur exempt de licence contenu dans le présent appareil est conforme aux CNR d'Innovation, Sciences et Développement économique Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes:

1. L'appareil ne doit pas produire de brouillage;

2. L'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Transmitter Antenna (From Section 6.8 RSS-GEN, Issue 5, February 2021): User manuals, for transmitters shall display the following notice in a conspicuous location:

This radio transmitter IC: 20266-20266-WIXCS02 and IC: 20266-20266-WIXCS02U have been approved by Innovation, Science and Economic Development Canada to operate with the antenna types listed below, with the maximum permissible gain indicated. Antenna types not included in this list that have a gain greater than the maximum gain indicated for any type listed are strictly prohibited for use with this device.

Le présent émetteur radio IC: 20266-20266-WIXCS02 and IC: 20266-20266-WIXCS02U a été approuvé par Innovation, Sciences et Développement économique Canada pour fonctionner avec les types d'antenne énumérés cidessous et ayant un gain admissible maximal. Les types d'antenne non inclus dans cette liste, et dont le gain est supérieur au gain maximal indiqué pour tout type figurant sur la liste, sont strictement interdits pour l'exploitation de l'émetteur.

Immediately following the above notice, the manufacturer shall provide a list of all antenna types approved for use with the transmitter, indicating the maximum permissible antenna gain (in dBi) and required impedance for each.

## 5.2.2 RF Exposure

All transmitters regulated by Innovation, Science and Economic Development Canada (ISED) must comply with RF exposure requirements listed in RSS-102 - Radio Frequency (RF) Exposure Compliance of Radiocommunication Apparatus (All Frequency Bands).

This transmitter is restricted for use with a specific antenna tested in this application for certification, and must not be co-located or operating in conjunction with any other antenna or transmitters within a host device, except in accordance with Canada multi-transmitter product procedures.

RNWF02PC/RNWF02PE/RNWF02UC/RNWF02UE: The device operates at an output power level which is within the ISED SAR test exemption limits at any user distance.

### Exposition aux RF

Tous les émetteurs réglementés par Innovation, Sciences et Développement économique Canada (ISED) doivent se conformer à l'exposition aux RF. exigences énumérées dans RSS-102 - Conformité à l'exposition aux radiofréquences (RF) des appareils de radiocommunication (toutes les bandes de fréquences).

Cet émetteur est limité à une utilisation avec une antenne spécifique testée dans cette application pour la certification, et ne doit pas être colocalisé ou fonctionner conjointement avec une autre antenne ou émetteur au sein d'un appareil hôte, sauf conformément avec les procédures canadiennes relatives aux produits multi-transmetteurs.

Les appareils fonctionnent à un niveau de puissance de sortie qui se situe dans les limites du DAS ISED. tester les limites d'exemption à toute distance d'utilisateur supérieure à 20 cm.

## 5.2.3 Approved Antenna Types

For the RNWF02PC/PE, the approval is received using the integral PCB antenna.

For the RNWF02UC/UE, approved antennas are listed in the [Table 2-4](#).

#### 5.2.4 Helpful Web Sites

Innovation, Science and Economic Development Canada (ISED): [www.ic.gc.ca/](http://www.ic.gc.ca/).

### 5.3 Europe

The RNWF02PC/RNWF02PE/RNWF02UC/RNWF02UE modules are a Radio Equipment Directive (RED) assessed radio module that is CE marked and has been manufactured and tested with the intention of being integrated into a final product.

The RNWF02PC/RNWF02PE/RNWF02UC/RNWF02UE modules have been tested to RED 2014/53/EU Essential Requirements mentioned in the following European Compliance table.

**Table 5-1.** European Compliance Information

| Certification | Standard      | Article |
|---------------|---------------|---------|
| Safety        | EN 62368      | 3.1a    |
| Health        | EN 62311      |         |
| EMC           | EN 301 489-1  | 3.1b    |
|               | EN 301 489-17 |         |
| Radio         | EN 300 328    | 3.2     |

The ETSI provides guidance on modular devices in the *"Guide to the application of harmonised standards covering articles 3.1b and 3.2 of the RED 2014/53/EU (RED) to multi-radio and combined radio and non-radio equipment"* document available at [http://www.etsi.org/deliver/etsi\\_eg/203300\\_203399/20\\_3367/01.01.01\\_60/eg\\_203367v010101p.pdf](http://www.etsi.org/deliver/etsi_eg/203300_203399/20_3367/01.01.01_60/eg_203367v010101p.pdf).

**Note:** To maintain conformance to the standards listed in the preceding European Compliance table, the module shall be installed in accordance with the installation instructions in this data sheet and shall not be modified. When integrating a radio module into a completed product, the integrator becomes the manufacturer of the final product and is therefore responsible for demonstrating compliance of the final product with the essential requirements against the RED.

#### 5.3.1 Labeling and User Information Requirements

The label on the final product that contains the RNWF02PC/RNWF02PE/RNWF02UC/RNWF02UE modules must follow CE marking requirements.

#### 5.3.2 Conformity Assessment

From ETSI Guidance Note EG 203367, section 6.1, when non-radio products are combined with a radio product:

If the manufacturer of the combined equipment installs the radio product in a host non-radio product in equivalent assessment conditions (i.e. host equivalent to the one used for the assessment of the radio product) and according to the installation instructions for the radio product, then no additional assessment of the combined equipment against article 3.2 of the RED is required.

##### 5.3.2.1 Simplified EU Declaration of Conformity

Hereby, Microchip Technology Inc. declares that the radio equipment type RNWF02PC/RNWF02PE/RNWF02UC/RNWF02UE modules are in compliance with Directive 2014/53/EU.

The full text of the EU declaration of conformity, for this product, is available at [www.microchip.com/design-centers/wireless-connectivity/](http://www.microchip.com/design-centers/wireless-connectivity/).

#### 5.3.3 Approved Antenna Types

For the RNWF02PC/PE, the approval is received using the integral PCB antenna.

For the RNWF02UC/UE, approved antennas are listed in the [Table 2-4](#).

### 5.3.4 Helpful Websites

A document that can be used as a starting point in understanding the use of Short Range Devices (SRD) in Europe is the European Radio Communications Committee (ERC) Recommendation 70-03 E, which can be downloaded from the European Communications Committee (ECC) at: [docdb.cept.org/](https://docdb.cept.org/).

Additional helpful web sites are:

- Radio Equipment Directive (2014/53/EU):  
[https://ec.europa.eu/growth/single-market/european-standards/harmonised-standards/red\\_en](https://ec.europa.eu/growth/single-market/european-standards/harmonised-standards/red_en)
- European Conference of Postal and Telecommunications Administrations (CEPT):  
<http://www.cept.org>
- European Telecommunications Standards Institute (ETSI):  
<http://www.etsi.org>
- The Radio Equipment Directive Compliance Association (REDCA):  
<http://www.redca.eu/>

## 5.4 UKCA (UK Conformity Assessed)

The RNWF02PC/RNWF02PE/RNWF02UC/RNWF02UE module is a UK conformity assessed radio module that meets all the essential requirements according to CE RED requirements.

### 5.4.1 Labeling Requirements for Module and User's Requirements

The label on the final product that contains the RNWF02PC/RNWF02PE/RNWF02UC/RNWF02UE module must follow UKCA marking requirements.



The UKCA mark above is printed on the module itself or on the packing label.

Additional details for the label requirement are available at:

<https://www.gov.uk/guidance/using-the-ukca-marking#check-whether-you-need-to-use-the-new-ukca-marking>.

### 5.4.2 UKCA Declaration of Conformity

Hereby, Microchip Technology Inc. declares that the radio equipment type the RNWF02PC/RNWF02PE/RNWF02UC/RNWF02UE modules are in compliance with the Radio Equipment Regulations 2017. The full text of the UKCA declaration of conformity for this product is available (under *Documents > Certifications*) at: [www.microchip.com/en-us/development-tool/EA32M85A](http://www.microchip.com/en-us/development-tool/EA32M85A).

### 5.4.3 Approved Antennas

The testing of the RNWF02PC/RNWF02PE/RNWF02UC/RNWF02UE module was performed with the antennas listed in [Table 2-4](#).

### 5.4.4 Helpful Websites

For more information on the UKCA regulatory approvals, refer to the [www.gov.uk/guidance/placing-manufactured-goods-on-the-market-in-great-britain](http://www.gov.uk/guidance/placing-manufactured-goods-on-the-market-in-great-britain).

## 5.5 Other Regulatory Information

- For information about other countries' jurisdictions not covered here, refer to the [www.microchip.com/design-centers/wireless-connectivity/certifications](http://www.microchip.com/design-centers/wireless-connectivity/certifications).
- Should other regulatory jurisdiction certification be required by the customer, or the customer needs to recertify the module for other reasons, contact Microchip for the required utilities and documentation.

## 6. Appendix B: Acronyms and Abbreviations

**Table 6-1.** Acronyms and Abbreviations

| Acronyms | Abbreviations                                      |
|----------|----------------------------------------------------|
| ADC      | Analog-to-Digital Converter                        |
| AES      | Advanced Encryption Standard                       |
| ASCII    | American Standard Code for Information Interchange |
| CBC      | Cypher Block Chaining                              |
| CDM      | Charged Device Model                               |
| CFB      | Cypher Feedback Mode                               |
| CLK      | Clock                                              |
| CMD      | Command                                            |
| CPU      | Central Processing Unit                            |
| CTR      | Counter Mode                                       |
| CTS      | Clear-to-Send                                      |
| DAC      | Digital-to-Analog Converter                        |
| DC       | Direct Current                                     |
| DES      | Data Encryption Standard                           |
| DFU      | Device Firmware Update                             |
| DNP      | Do Not Populate                                    |
| ECB      | Electronic Code Book                               |
| ECC      | Elliptic-Curve Cryptography                        |
| EMC      | Electro-Magnetic Compatibility                     |
| EMI      | Electro-Magnetic Interference                      |
| ESD      | Electrostatic Discharge                            |
| ESR      | Effective Series Resistance                        |
| EVM      | Error Vector Magnitude                             |
| FCC      | Federal Communications Commission                  |
| GND      | Ground                                             |
| GPIO     | General Purpose I/O                                |
| HBM      | Human Body Model                                   |
| HPA      | High Power Amplifier                               |
| HTTP     | Hypertext Transfer Protocol                        |
| I2C      | Inter-Integrated Circuit                           |
| IP       | Internet Protocol                                  |
| I/O      | Input Output                                       |
| IPWR     | Idle Current                                       |
| ISED     | Innovation, Science and Economic Development       |
| ISM      | International Safety Management Certification      |
| LNA      | Low Noise Amplifier                                |
| MCLR     | Master Clear Reset Active Low                      |
| MSB      | Most Significant Bit                               |
| NC       | No Connection                                      |
| NDRNG    | Non Deterministic Random Number Generator          |
| NIST     | National Institute of Standards and Technology     |
| OEM      | Original Equipment Manufacturer                    |

.....continued

| Acronyms | Abbreviations                               |
|----------|---------------------------------------------|
| OFB      | Output Feedback Mode                        |
| OFDM     | Orthogonal Frequency Division Multiplexing  |
| OSC      | Oscillator                                  |
| OTA      | Over-the-Air                                |
| OTP      | One Time Programmable                       |
| PA       | Power Amplifier                             |
| PCB      | Printed Circuit Board                       |
| PMF      | Protected Management Frame                  |
| PMU      | Power Management Unit                       |
| POR      | Power-on Reset                              |
| POSC     | Primary Oscillator                          |
| PRI0     | Priority                                    |
| PTA      | Packet Traffic Arbitration                  |
| PWM      | Pulse Width Modulation                      |
| RF       | Radio Frequency                             |
| ROM      | Read Only Memory                            |
| RP       | Reverse Polarity                            |
| RSSI     | Receive Signal Strength Indication          |
| RTC      | Real Time Counter                           |
| RTCC     | Real Time Clock Calendar                    |
| RTS      | Request-to-Send                             |
| RX       | Receive                                     |
| SMA      | SubMiniature Connector                      |
| SMD      | Surface Mount Device                        |
| SRAM     | Static Random Access Memory                 |
| SSL      | Secure Sockets Layer                        |
| STM      | Standard Test Method                        |
| TCP      | Transmission Control Protocol               |
| TLS      | Transport Layer Security                    |
| TP       | Test Point                                  |
| TPC      | Transmit Power Control                      |
| TX       | Transmit                                    |
| UART     | Universal Asynchronous Receiver/Transmitter |
| UDP      | Unified Data Packet                         |
| VQFN     | Very Thin Quad Flat No-lead                 |
| WLAN     | Wireless Local Area Network                 |
| WPA      | Wi-Fi® Protected Access                     |
| XOSC     | Crystal Oscillator                          |

## 7. Document Revision History

The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

**Table 7-1.** Document Revision History

| Revision | Date    | Section                               | Description                                                                                                                                                                                                                                                                                                                                      |
|----------|---------|---------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B        | 09/2024 | Introduction                          | "Microchip Trust&Go secure device" changed into "Trust&GO Crypto Authentication" Device"                                                                                                                                                                                                                                                         |
|          |         | Features                              | <ul style="list-style-type: none"> <li>"Microchip Trust&amp;Go secure device" changed into "Trust&amp;GO Crypto Authentication" Device"</li> <li>Updated the notes and added note reference</li> </ul>                                                                                                                                           |
|          |         | Module Ordering Information           | <ul style="list-style-type: none"> <li>Added regulatory certification</li> <li>Updated the ordering code</li> <li>Removed the following ordering code: <ul style="list-style-type: none"> <li>RNWF02PET-I</li> <li>RNWF02PCT-I</li> <li>RNWF02UET-I</li> <li>RNWF02UCT-I</li> </ul> </li> <li>Updated the ordering information figure</li> </ul> |
|          |         | Device Overview                       | Updated the block diagram                                                                                                                                                                                                                                                                                                                        |
|          |         | Pin Details of RNWF02 Module          | <ul style="list-style-type: none"> <li>Updated the pin diagram</li> <li>Updated the pin description for I2C_SCL, I2C_SDA, UART1_TX, UART1_TX and DFU_TX/Strap2</li> <li>Updated the pin type for PTA_BT_PRIO, INT0/Wake, SOSCI/PTA_BT_ACTIVE, SOSCI/PTA_BT_ACTIVE and UART2_TX</li> </ul>                                                        |
|          |         | Basic Connection Requirement          | <ul style="list-style-type: none"> <li>Updated basic connection and interface diagram</li> <li>Added note for strap 1 pin</li> </ul>                                                                                                                                                                                                             |
|          |         | Power Supply Pin                      | Updated power supply connections diagram                                                                                                                                                                                                                                                                                                         |
|          |         | Device Firmware Update                | <ul style="list-style-type: none"> <li>Updated the note with latest weblink</li> <li>Updated basic connection diagram of DFU</li> </ul>                                                                                                                                                                                                          |
|          |         | Interface with Host Microcontroller   | UART_TX, UART_RX, UART_RTS, UART_CTS are changed into UART1_TX, UART1_RX, UART1_RTSn, UART1_CTSn                                                                                                                                                                                                                                                 |
|          |         | RNWF02 Module Routing Guidelines      | <ul style="list-style-type: none"> <li>GPIOs pin changed into reserved pins and digital interface pins</li> <li>Updated example of host board on top layer diagram</li> </ul>                                                                                                                                                                    |
|          |         | PCB Antenna                           | <ul style="list-style-type: none"> <li>Updated the dimension in notes</li> <li>Updated the module orientation for radiation pattern measurement diagram with latest board image</li> </ul>                                                                                                                                                       |
|          |         | External Antennas                     | <ul style="list-style-type: none"> <li>Updated the approved external antenna list</li> <li>Updated the notes and provided reference to the table</li> </ul>                                                                                                                                                                                      |
|          |         | Wi-Fi Current Consumption             | <ul style="list-style-type: none"> <li>Updated Output Power (Typ.) and Current (Typ.) values</li> <li>Updated the notes and added reference to the table</li> </ul>                                                                                                                                                                              |
|          |         | RNWF02 Module Receiver Performance    | <ul style="list-style-type: none"> <li>Updated the description for WF_RX_2, WF_RX_5 and WF_RX_6</li> <li>Updated minimum value for WF_RX_5</li> </ul>                                                                                                                                                                                            |
|          |         | RNWF02 Module Transmitter Performance | Updated the description for WF_TX_2                                                                                                                                                                                                                                                                                                              |
|          |         | Appendix A: Regulatory Approval       | Added regulatory approval section                                                                                                                                                                                                                                                                                                                |

| .....continued |         |          |                  |
|----------------|---------|----------|------------------|
| Revision       | Date    | Section  | Description      |
| A              | 11/2023 | Document | Initial Revision |

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